



Introduction to Beam Instrumentation

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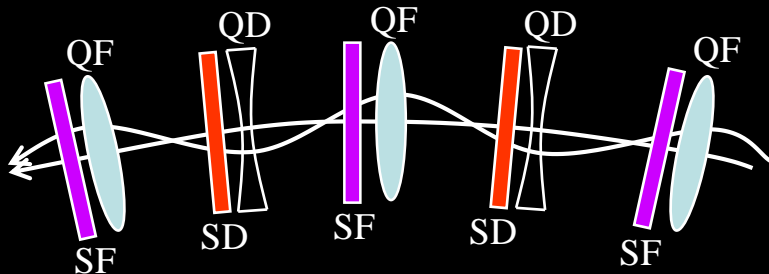


Introduction

- **What do we mean by beam instrumentation?**
 - The “eyes” of the machine operators
 - i.e. the instruments that observe beam behaviour
 - An accelerator can never be better than the instruments measuring its performance!
- **What does work in beam instrumentation entail?**
 - Design, construction & operation of instruments to observe particle beams
 - R&D to find new or improve existing techniques to fulfill new requirements
 - A combination of the following disciplines
 - Applied & Accelerator Physics; Mechanical, Electronic & Software Engineering
 - A fascinating field of work!
- **What beam parameters do we measure?**
 - Beam Position
 - Horizontal and vertical throughout the accelerator
 - Beam Intensity (& lifetime measurement for a storage ring/collider)
 - Bunch-by-bunch charge and total circulating current
 - Beam Loss
 - Especially important for high brightness and superconducting machines
 - Beam profiles
 - Transverse and longitudinal distribution

More Measurements

- Machine Tune

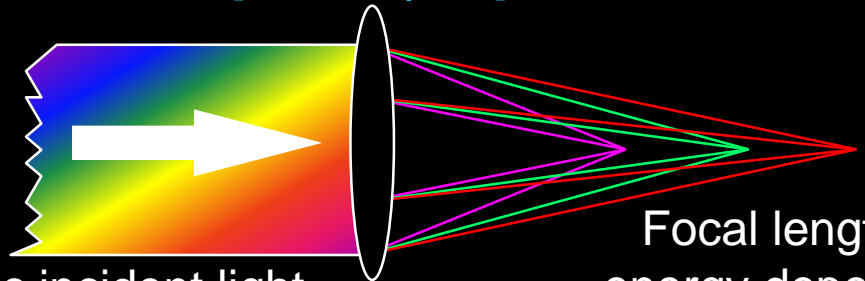


Characteristic Frequency
of the Magnetic Lattice
Given by the strength of the
Quadrupole magnets

- Machine Chromaticity

Optics Analogy:

Lens
[Quadrupole]



Achromatic incident light
[Spread in particle energy]

Focal length is
energy dependent

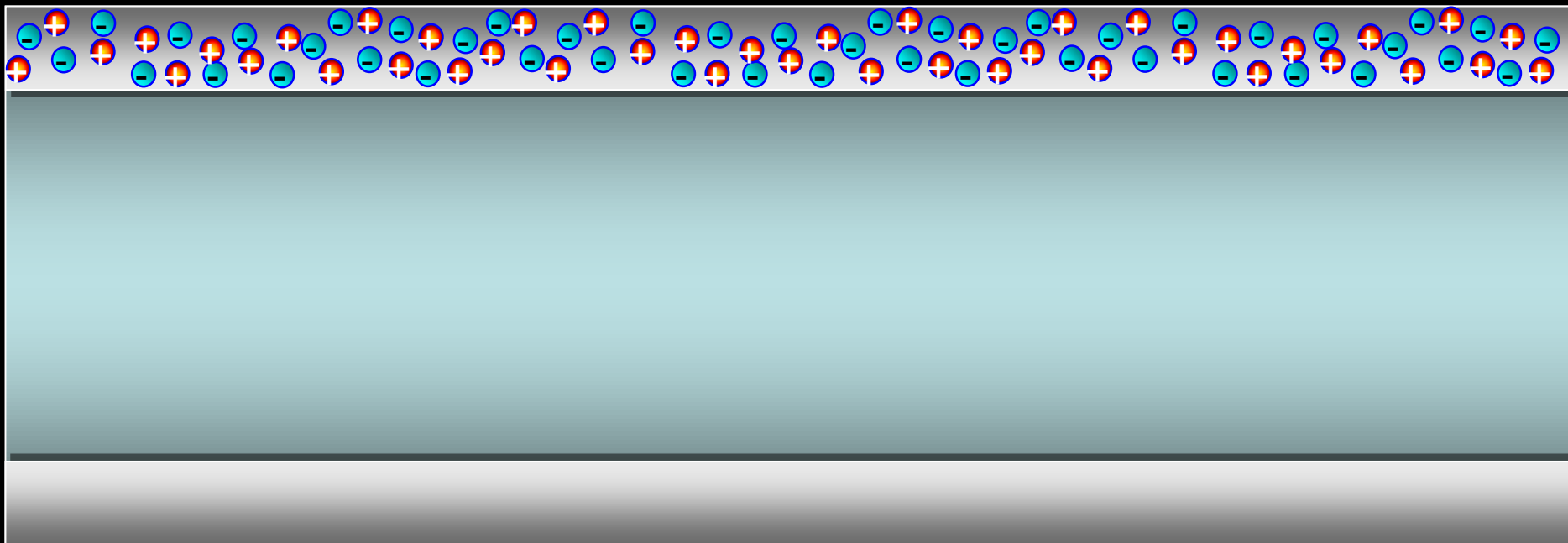
Spread in the Machine
Tune due to Particle
Energy Spread
Controlled by Sextupole
magnets



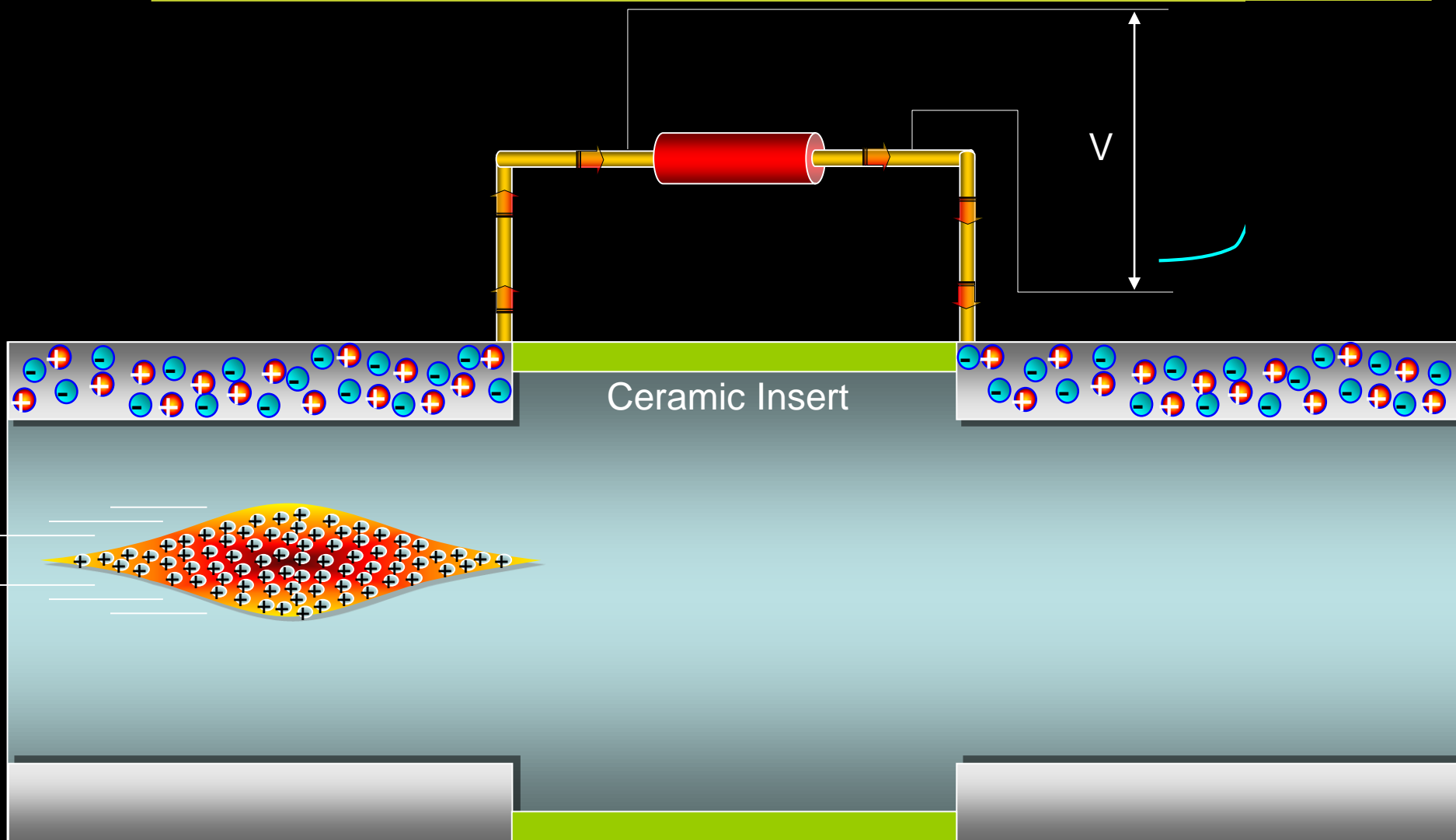
The Typical Instruments

- **Beam Position**
 - electrostatic or electromagnetic pick-ups and related electronics
- **Beam Intensity**
 - beam current transformers
- **Beam Profile**
 - secondary emission grids and screens
 - wire scanners
 - synchrotron light monitors
 - ionisation and luminescence monitors
 - femtosecond diagnostics for ultra short bunches
- **Beam Loss**
 - ionisation chambers or pin diodes
- **Machine Tune and Chromaticity**
 - in Beam Diagnostics lecture of tomorrow

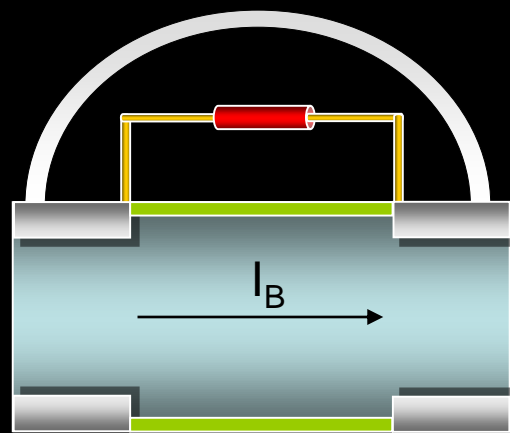
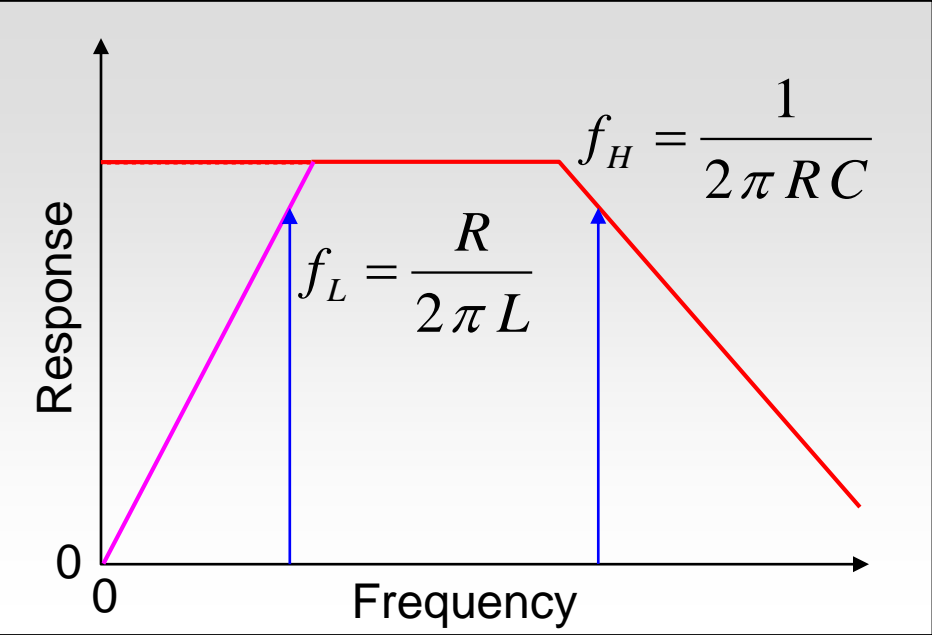
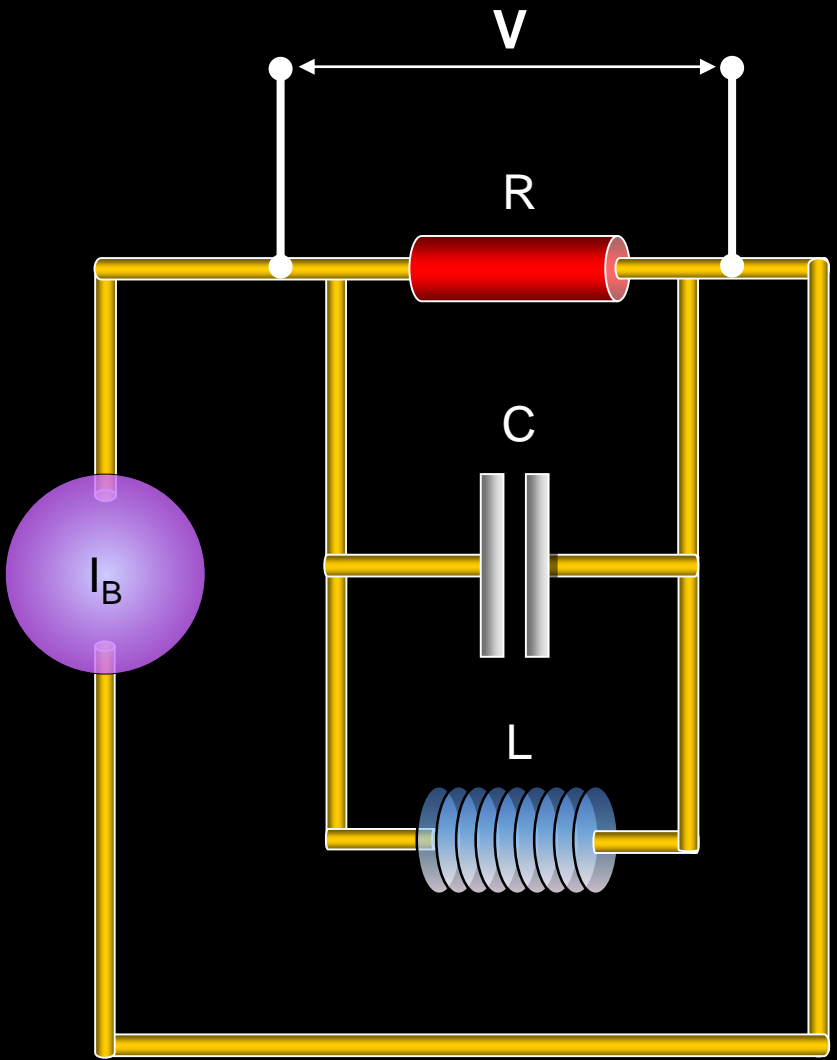
Measuring Beam Position – The Principle



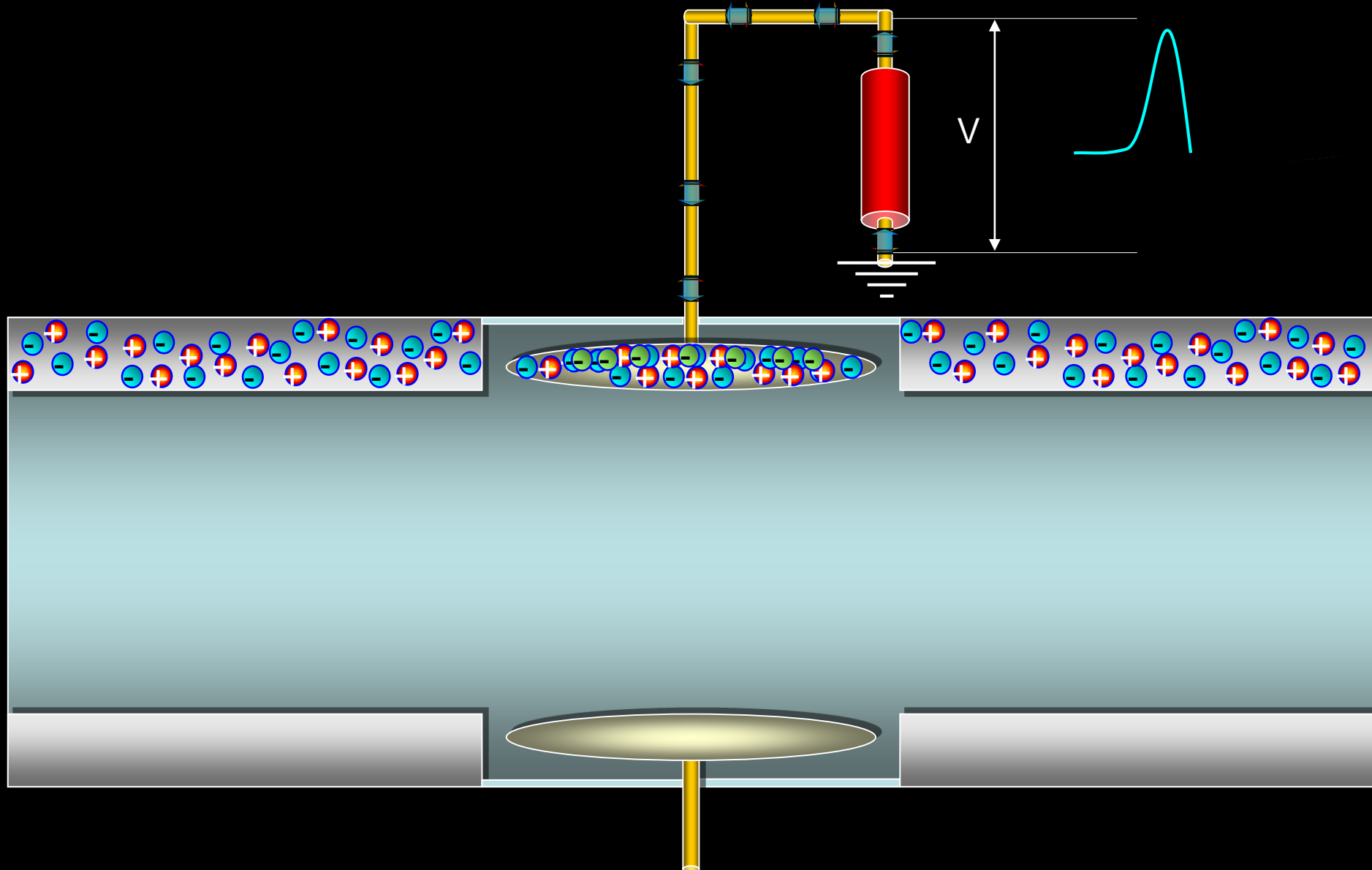
Wall Current Monitor – The Principle



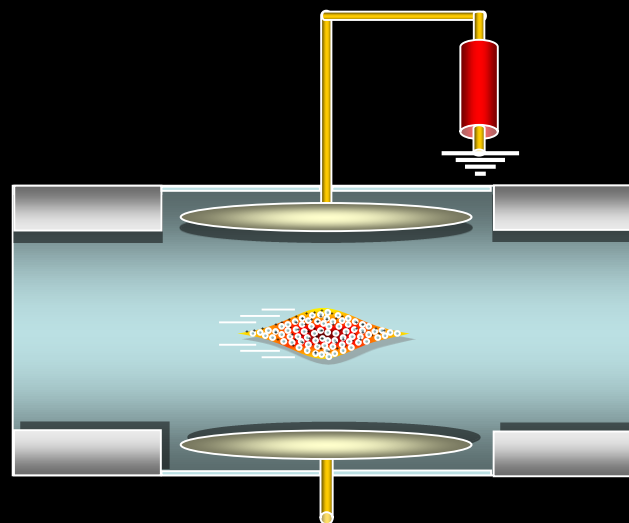
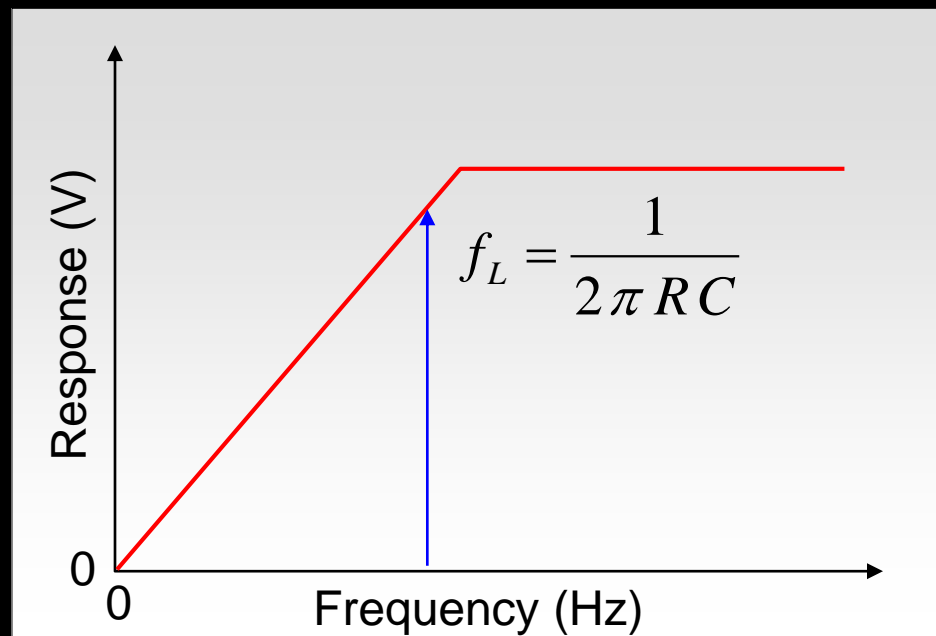
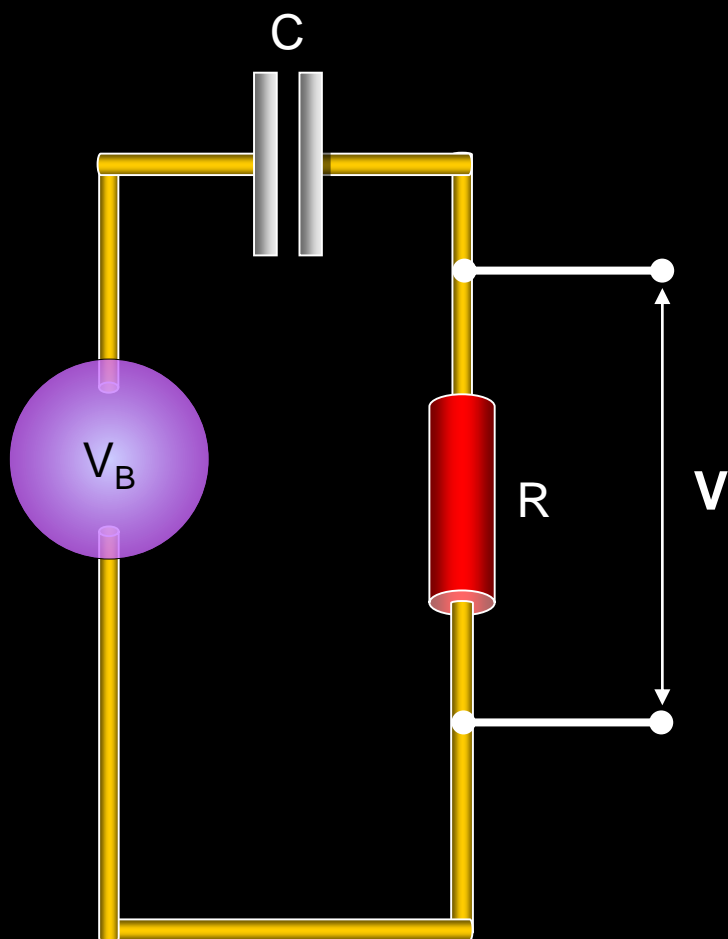
Wall Current Monitor – Beam Response



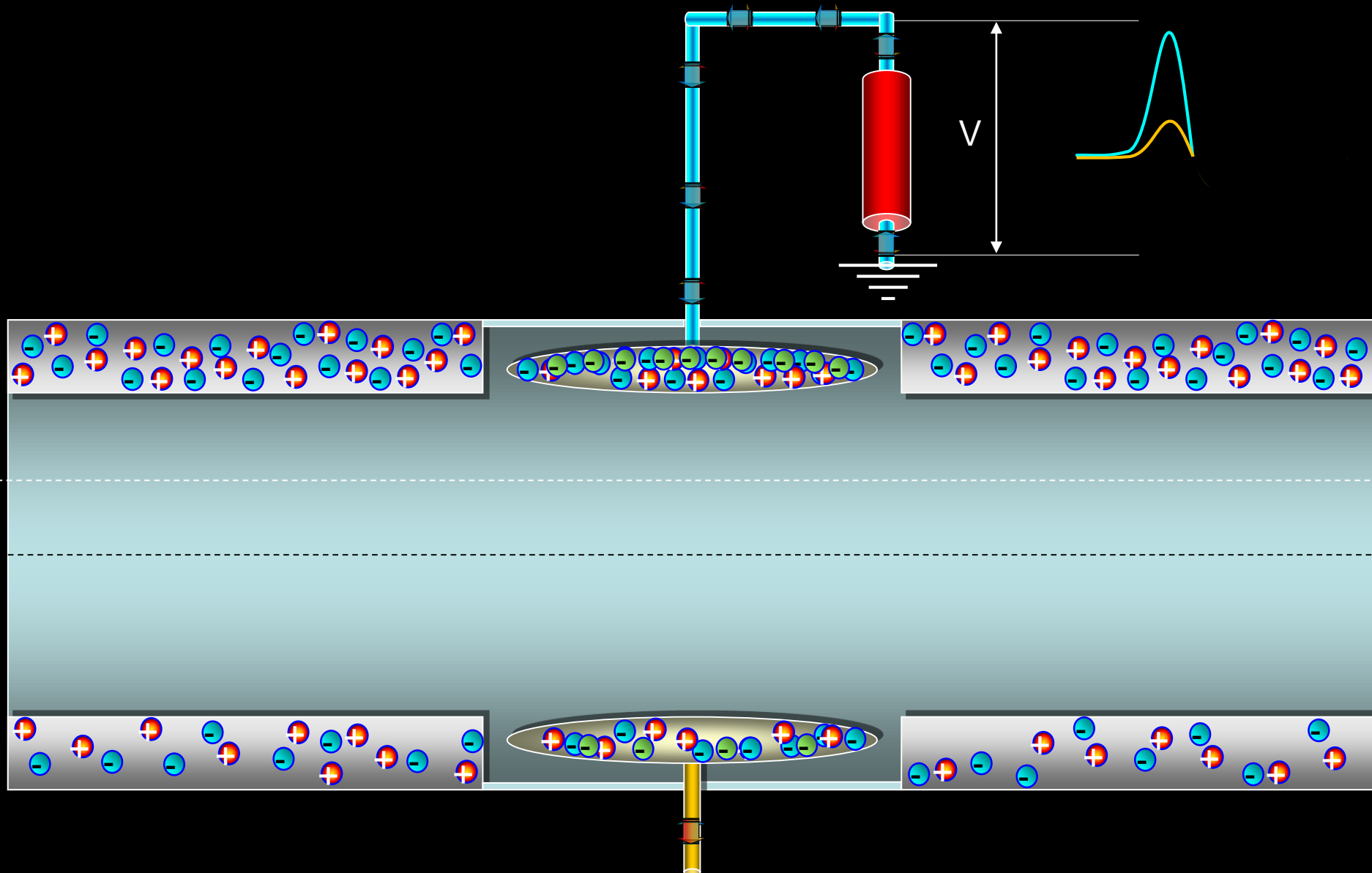
Electrostatic Monitor – The Principle



Electrostatic Monitor – Beam Response



Electrostatic Beam Position Monitor



Electrostatic Pick-up – Button

- ✓ Low cost \Rightarrow most popular
- ✗ Non-linear

- requires correction algorithm when beam is off-centre

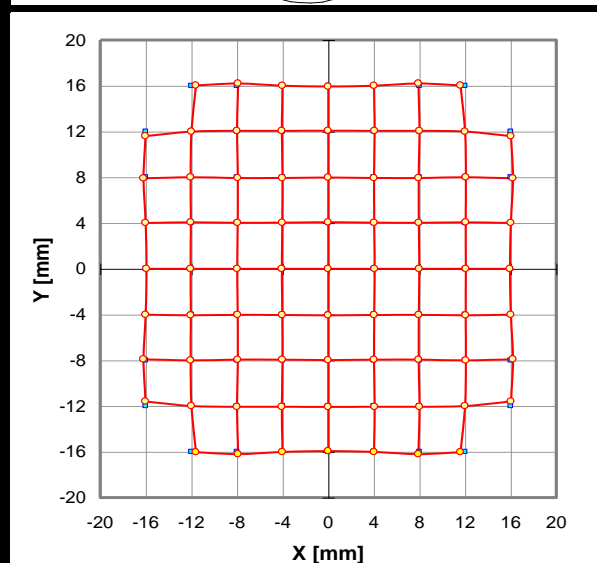
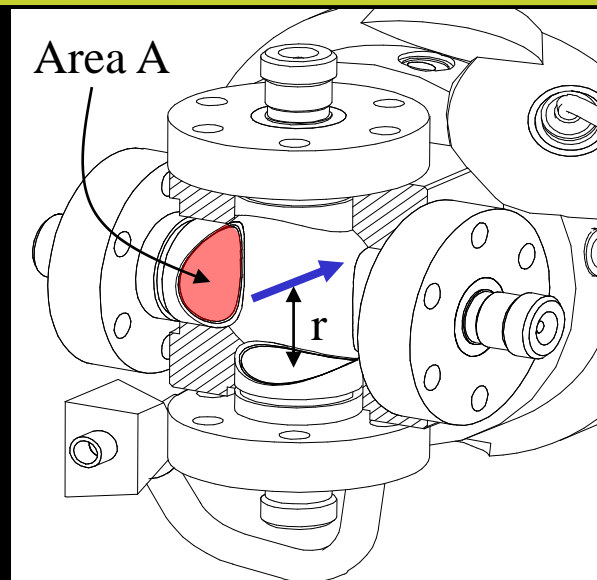
For Button with Capacitance C_e & Characteristic Impedance R_0

Transfer Impedance:

$$Z_{T(f \gg f_c)} = \frac{A}{(2\pi r) \times c \times C_e}$$

Lower Corner Frequency:

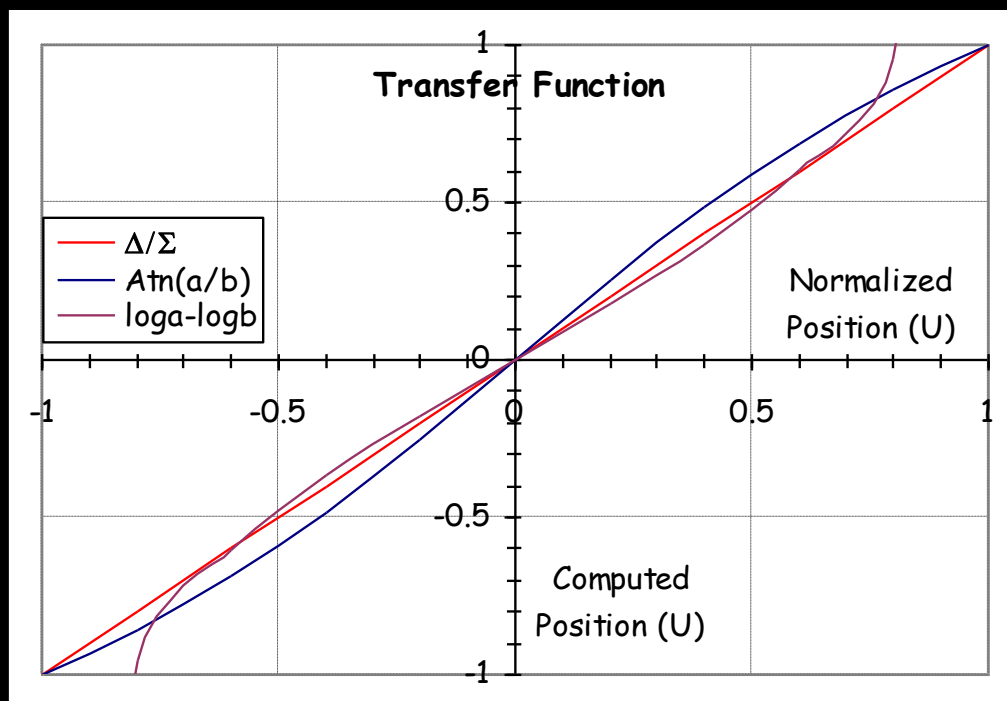
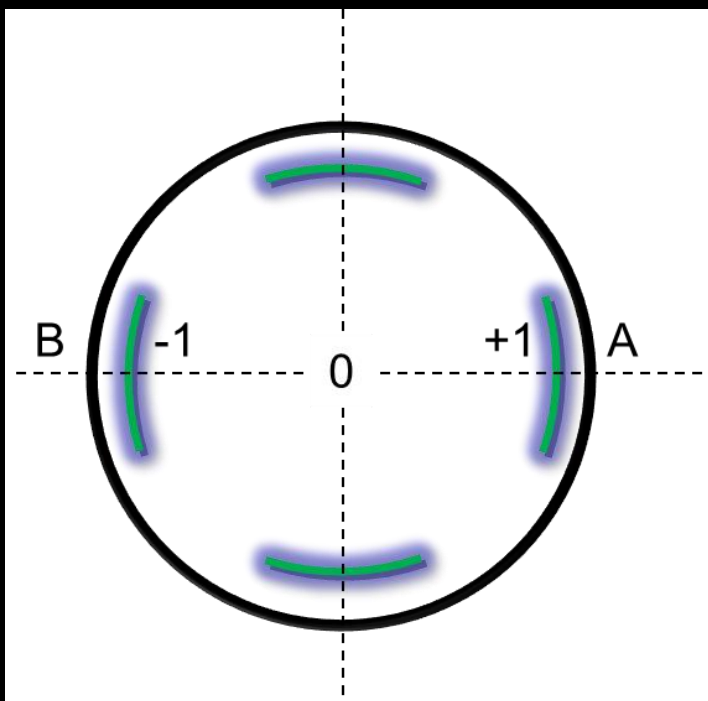
$$f_L = \frac{1}{2\pi R_0 C_e}$$



$$X = 2.30 \cdot 10^{-5} X_1^5 + 3.70 \cdot 10^{-5} X_1^3 + 1.035 X_1 + 7.53 \cdot 10^{-6} X_1^3 Y_1^2 + 1.53 \cdot 10^{-5} X_1 Y_1^4$$

Normalising the Position Reading

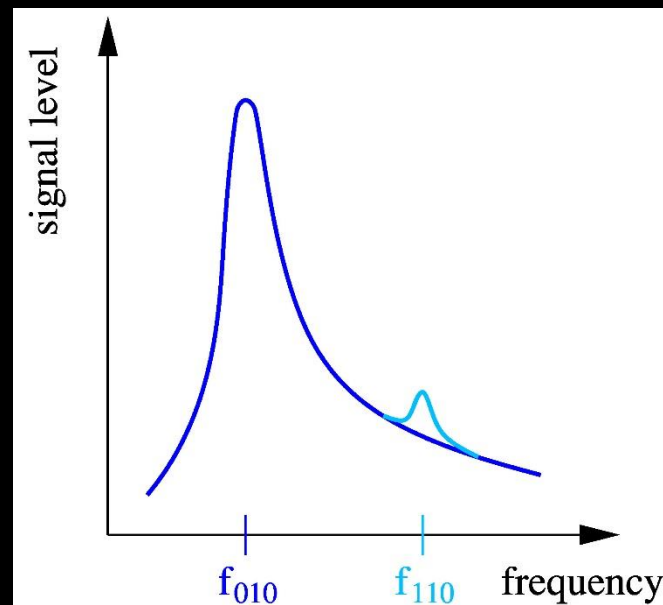
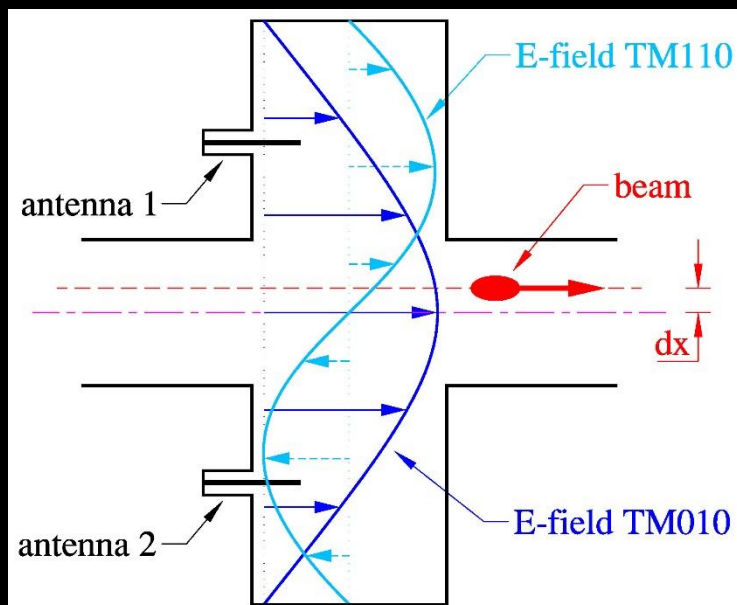
- To make it independent of intensity
- 3 main methods:
 - Difference/Sum : $(V_A - V_B) / (V_A + V_B) = \Delta / \Sigma$
 - Phase : $\text{Arctan}(V_A / V_B)$
 - Logarithm : $\text{Log}(V_A) - \text{Log}(V_B)$



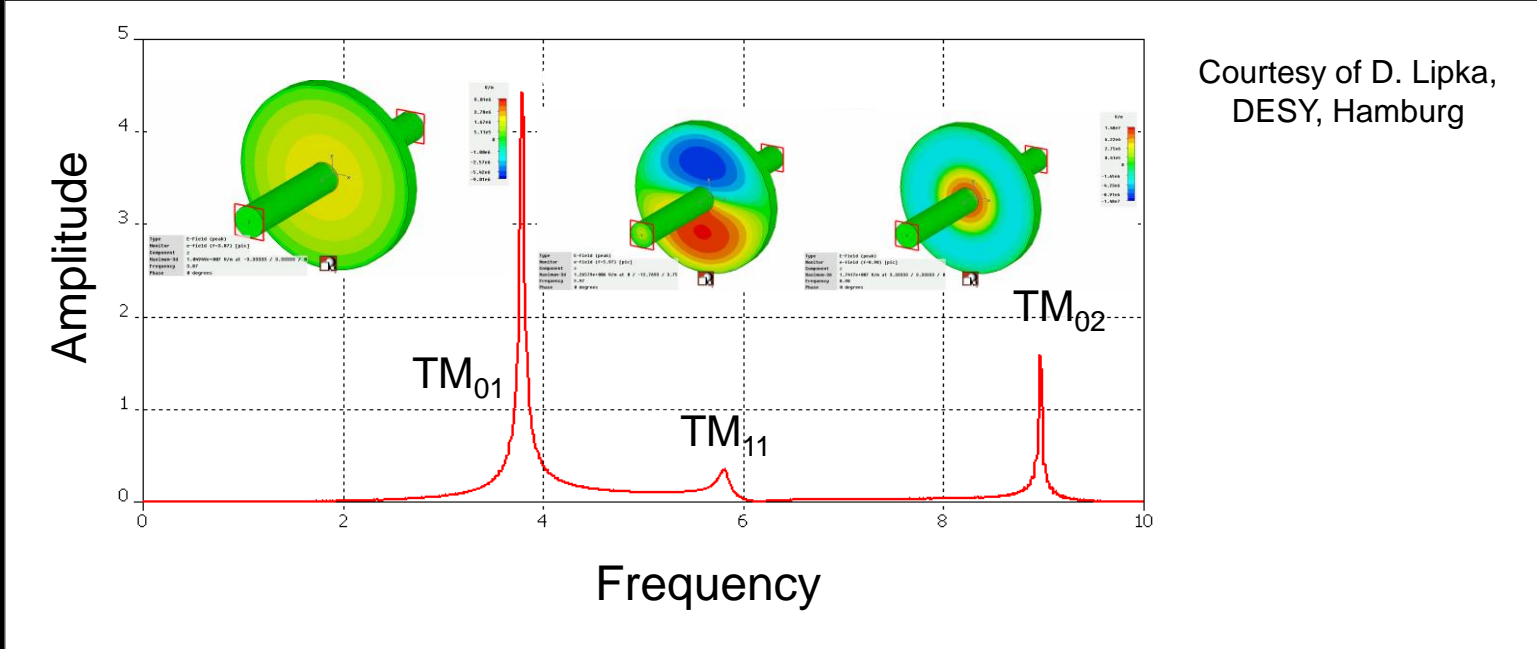


Improving Precision for Next Generation Accelerators

- BPM electrodes typically give “intensity signals” with some position dependence!
 - Need to remove intensity content to get to the position
 - Difficult to do electronically without some intensity information leaking through
 - When looking for small differences this leakage can dominate the measurement
- **Solution – cavity BPM allowing sub micron resolution**
 - Design the detector to collect only the difference signal
 - Dipole Mode TM_{11} proportional to POSITION OFFSET (& intensity)
 - Shifted in frequency with respect to intensity dependent Monopole Mode TM_{01}



Cavity Beam Position Monitors



Monopole Mode

Type	E-Field (peak)
Monitor	e-Field (F=3.88) [pic]
Component	Normal
Maximum-3d	1.17338e+007 U/m at -3.5 / 3.5 / 0
Frequency	3.88
Phase	0 degrees

Obtain signal using waveguides that only couple to dipole mode for further Monopole Suppression

Dipole Mode

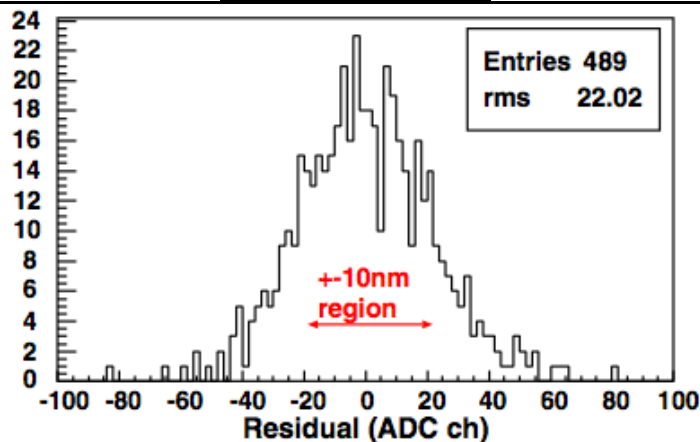
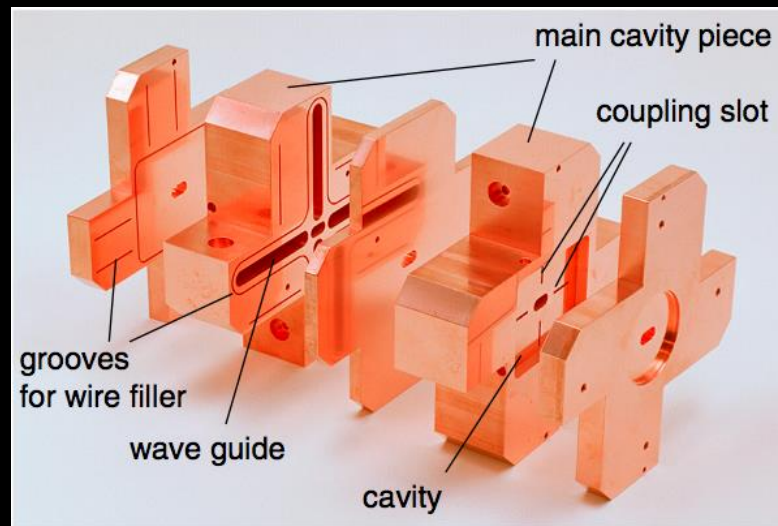
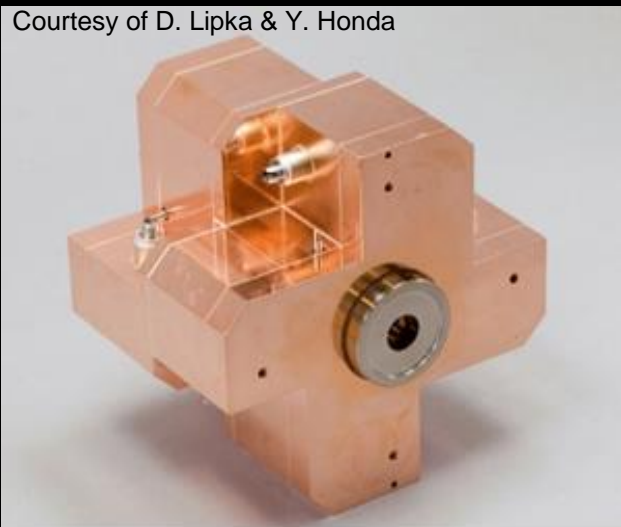
Type	E-Field (peak)
Monitor	e-Field (F=5.65) [pic]
Component	Normal
Maximum-3d	639869 U/m at 0 / 2 / 0
Frequency	5.65
Phase	0 degrees

Today's State of the Art BPMs

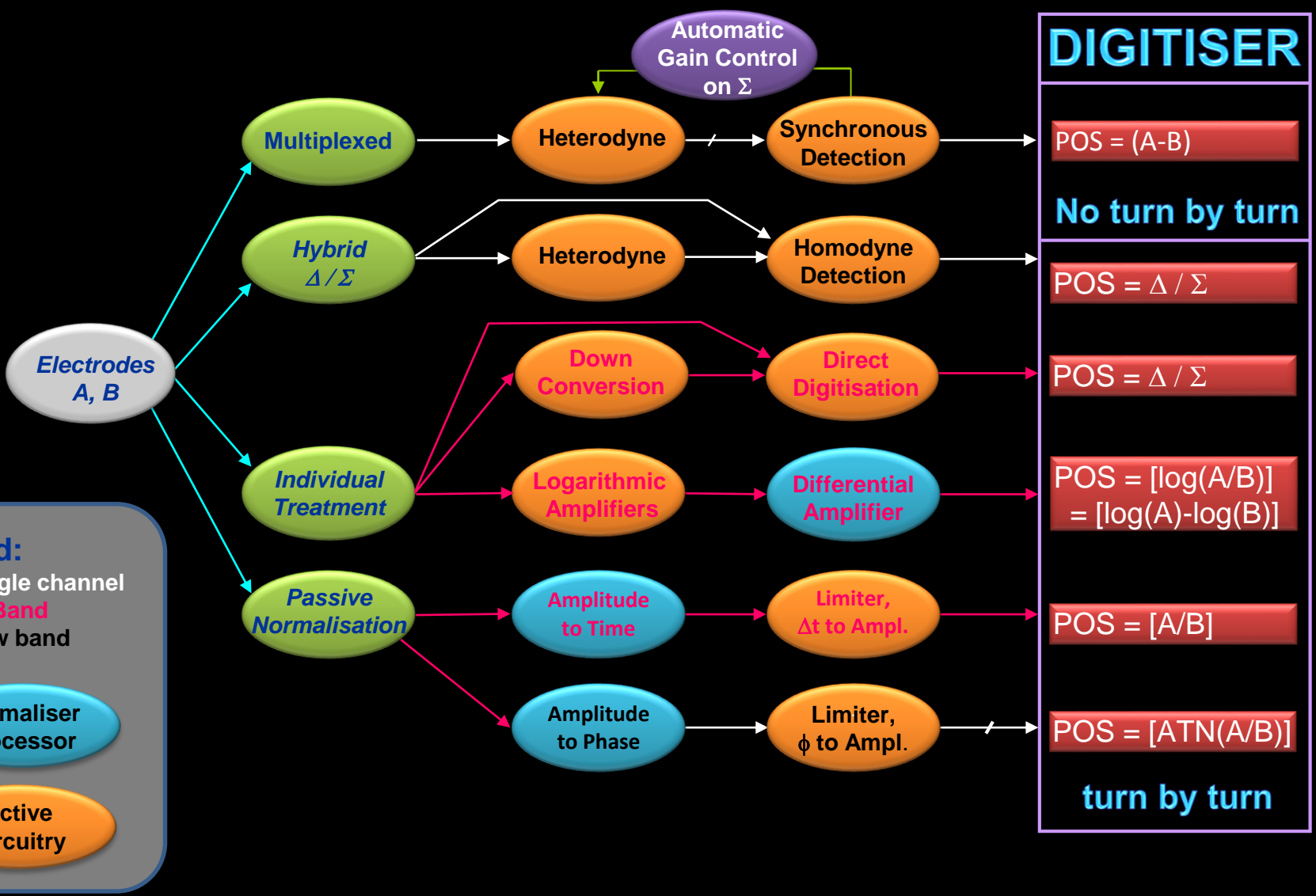
- **Prototype BPM for ILC Final Focus**

- Required resolution of 2nm (yes nano!) in a $6 \times 12\text{mm}$ diameter beam pipe
- Achieved World Record (so far!) resolution of 8.7nm at ATF2 (KEK, Japan)

Courtesy of D. Lipka & Y. Honda



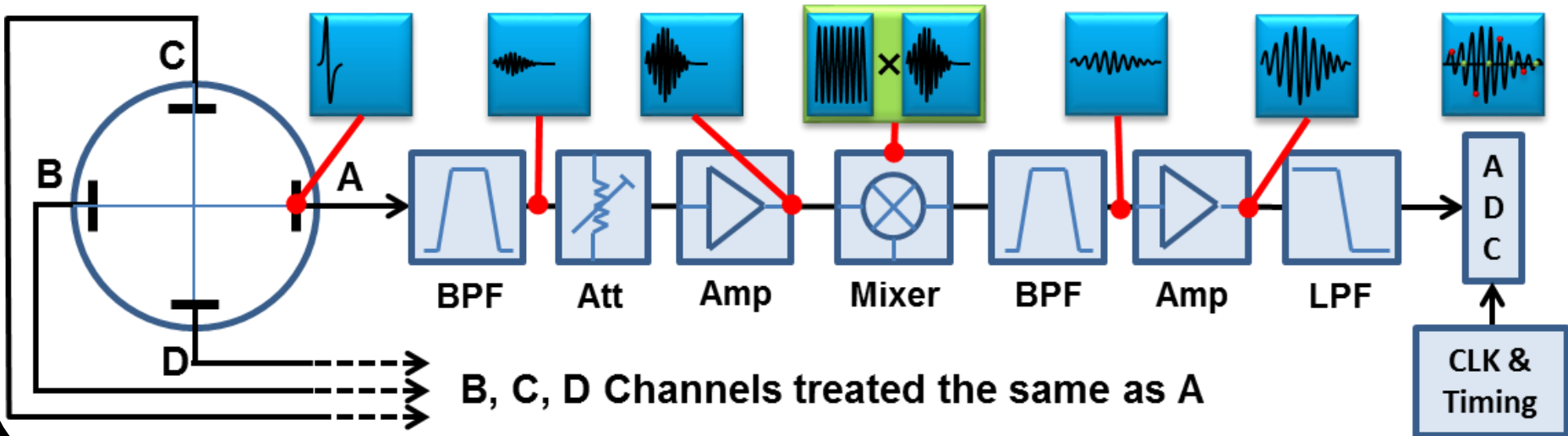
Processing System Families



Modern BPM Read-out Electronics

- Based on the individual treatment of the electrode signals
 - Use of frequency domain signal processing techniques
 - Developed for telecommunications market
 - Rely on high frequency & high resolution analogue to digital converters
 - Minimising analogue circuitry
 - Frequency down-conversion used if necessary to adapt to ADC sampling rate
 - All further processing carried out in the subsequent digital electronics

A-Electrode Analogue Conditioning

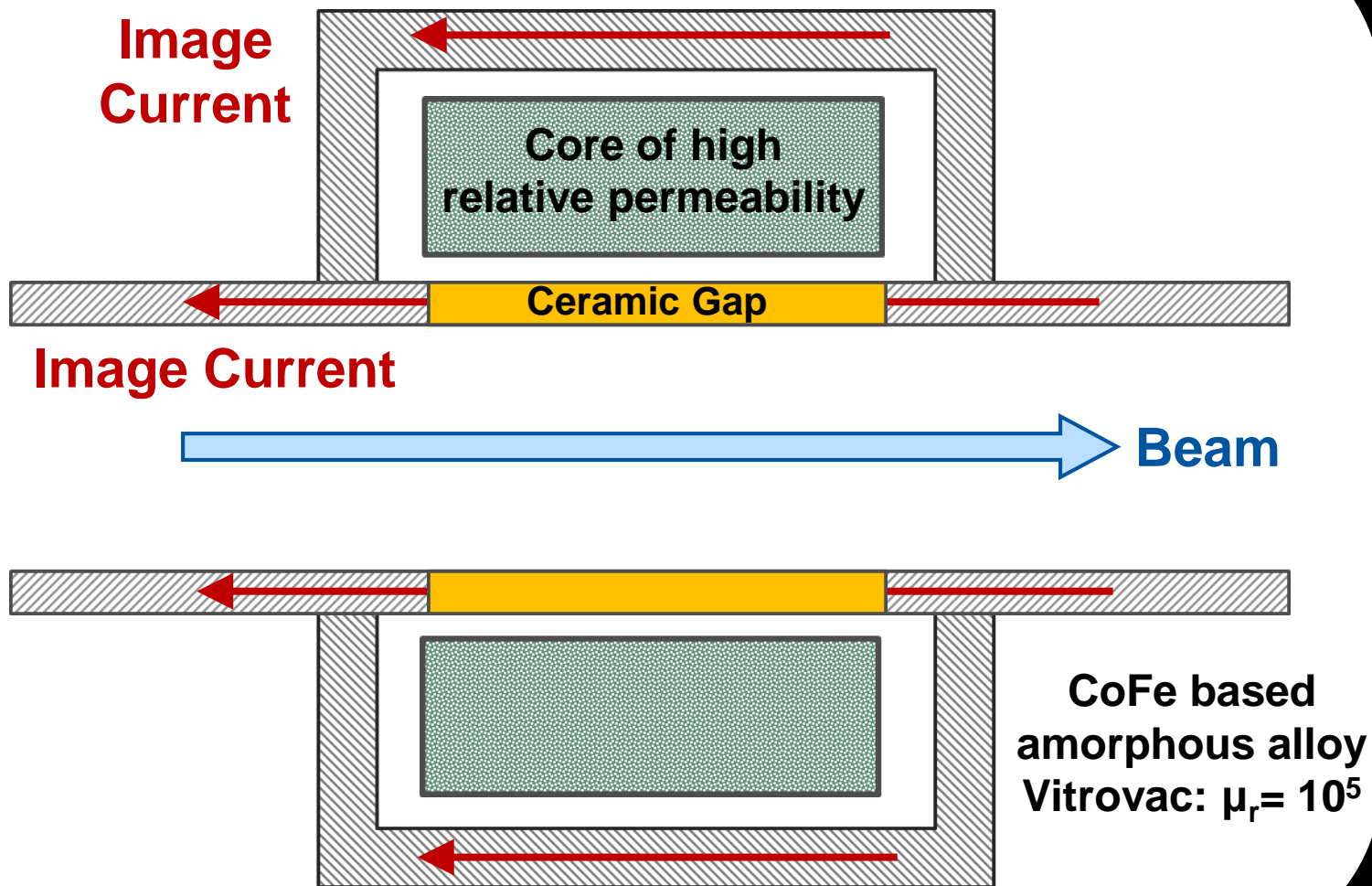




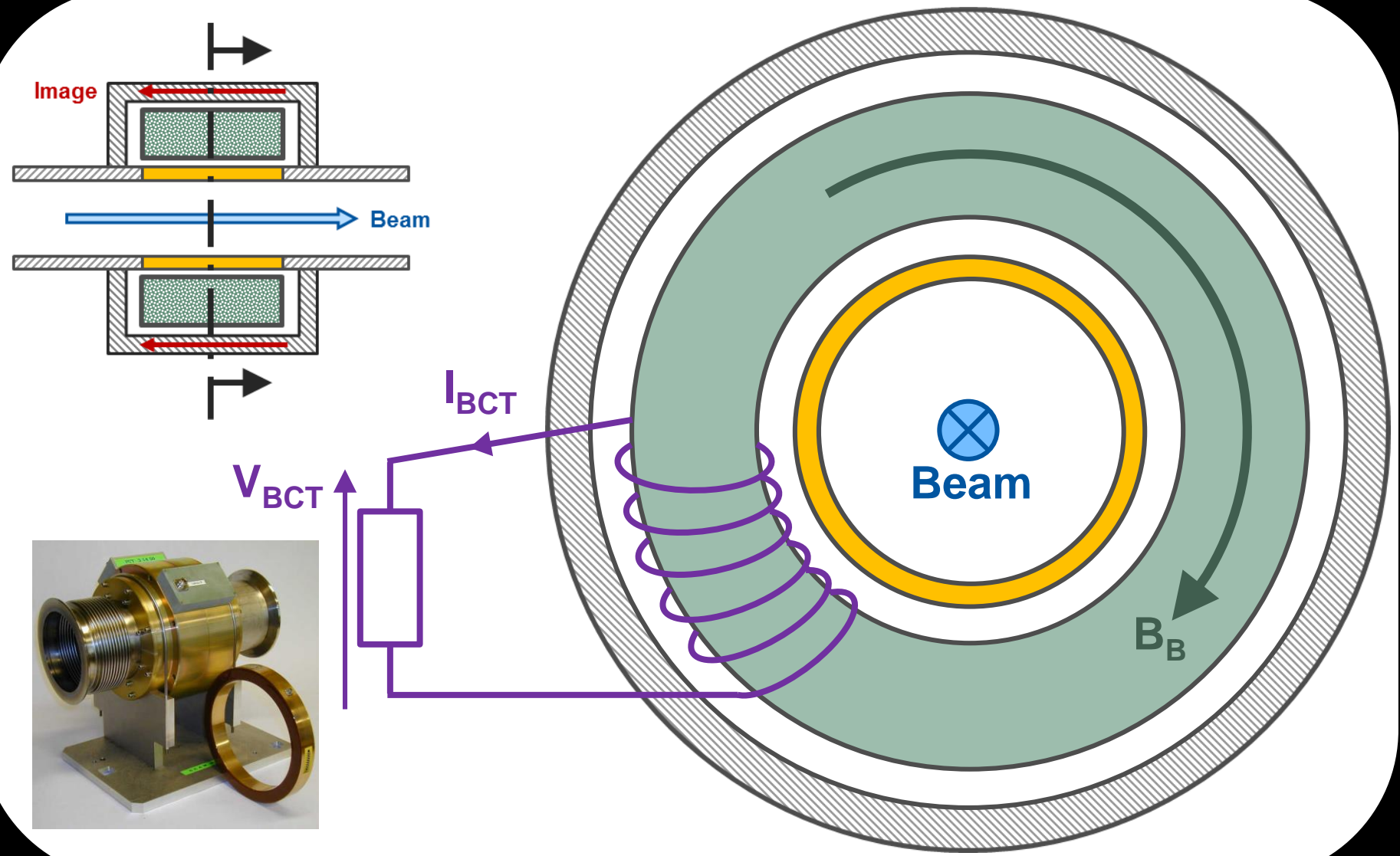
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AC (Fast) Current Transformers



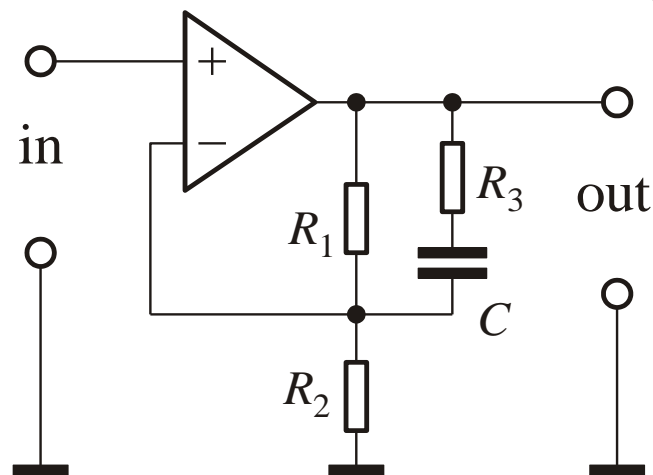
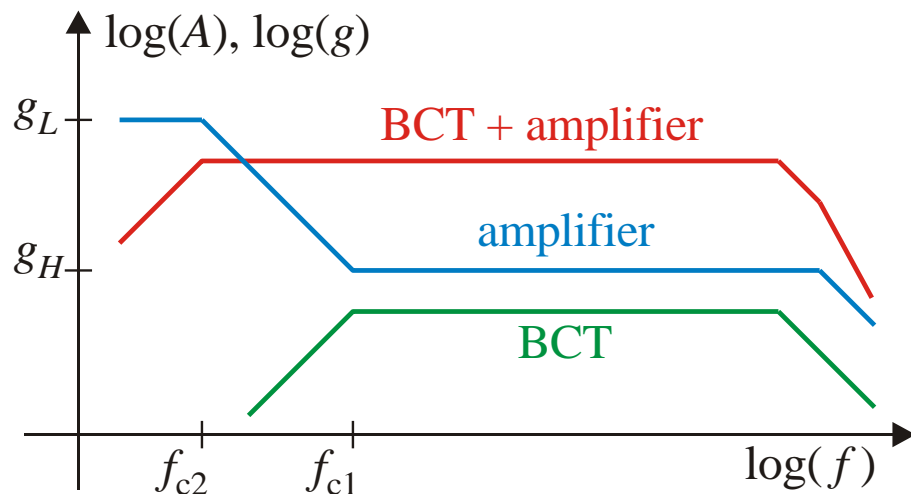
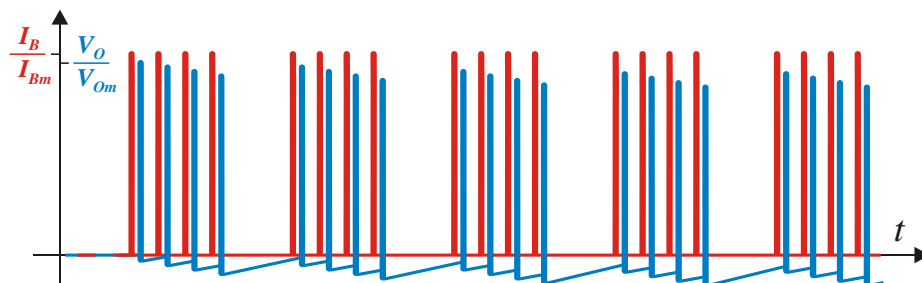
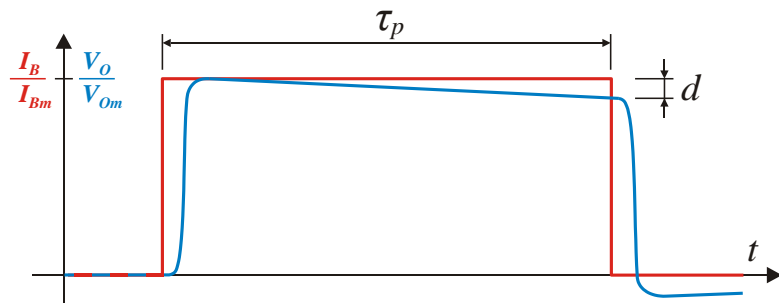
AC (Fast) Current Transformers



AC (Fast) Transformer Response

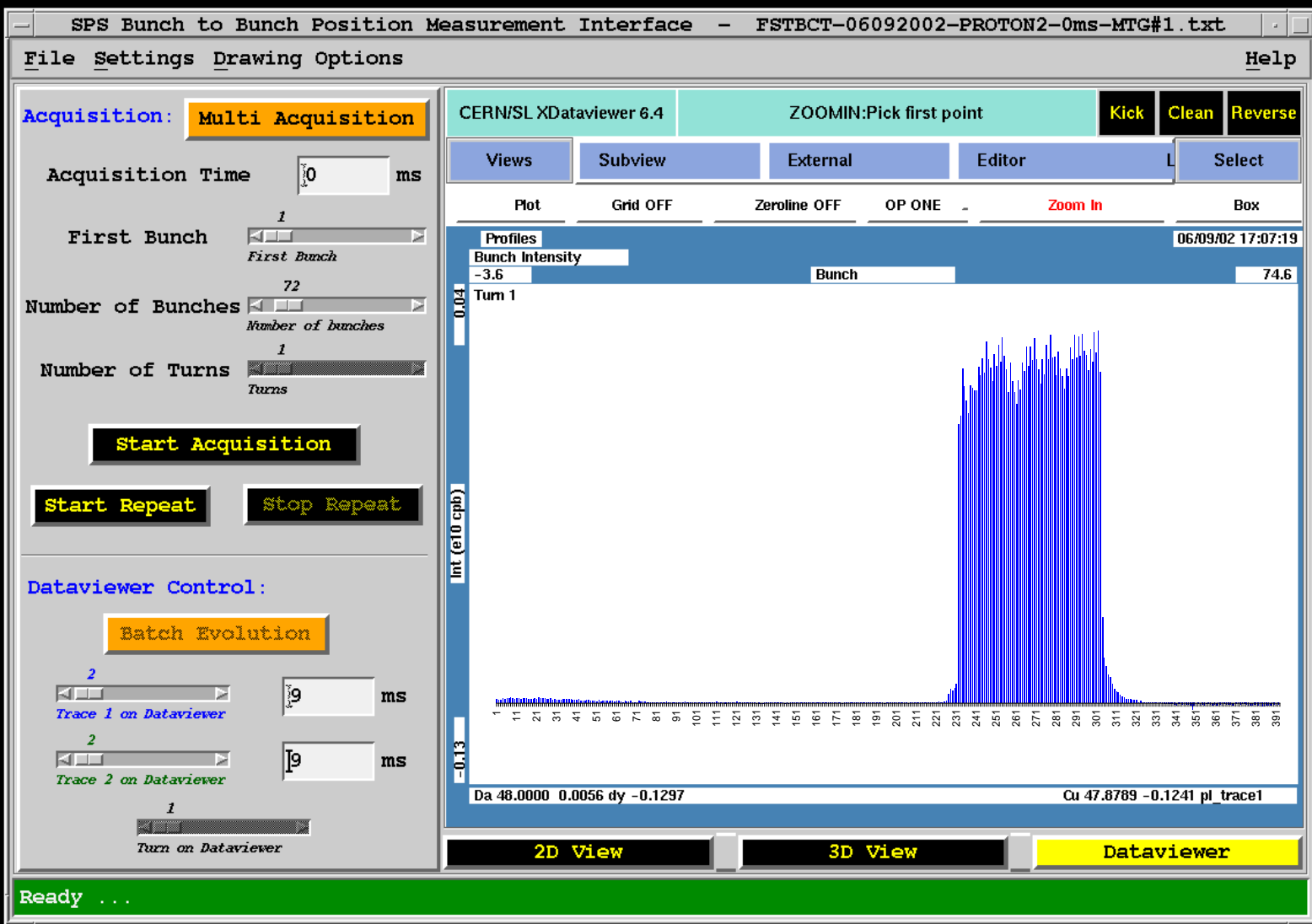
- **Low cut-off**

- Impedance of secondary winding decreases at low frequency
- Results in signal droop and baseline shift
- Mitigated by baseline restoration techniques (analogue or digital)





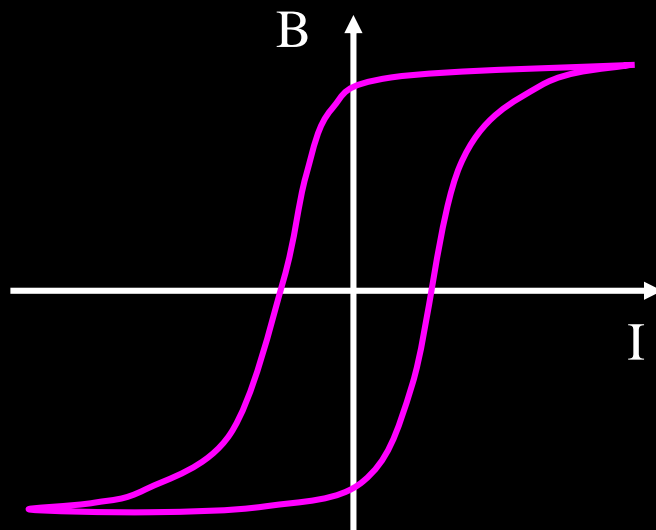
What one can do with such a System



Bad RF Capture of a single LHC Batch in the SPS (72 bunches)

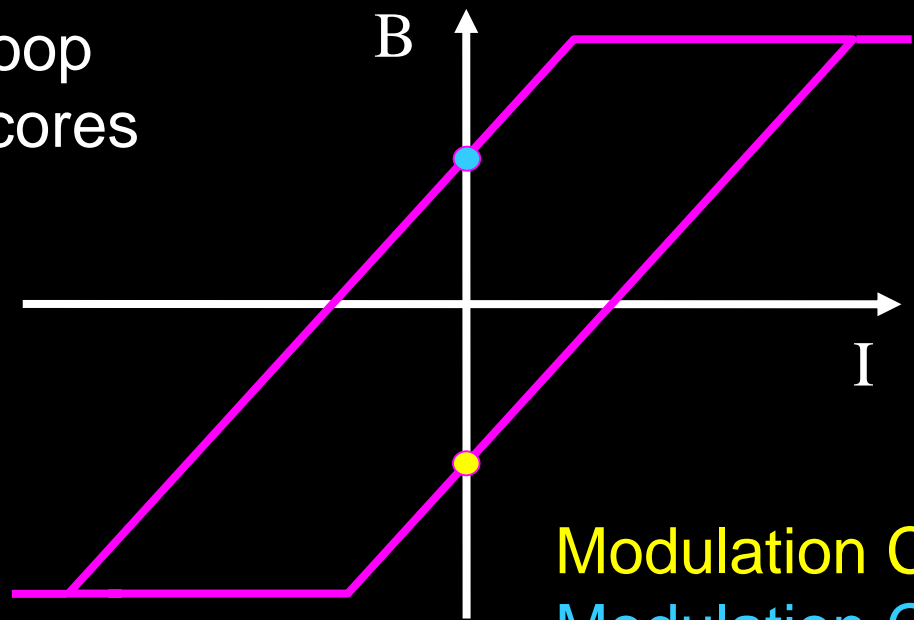
The DC transformer

- AC transformers can be extended to very low frequency but not to DC (no dl/dt !)
- DC measurement is required in storage rings
- To do this:
 - Take advantage of non-linear magnetisation curve
 - Use 2 identical cores modulated with opposite polarities

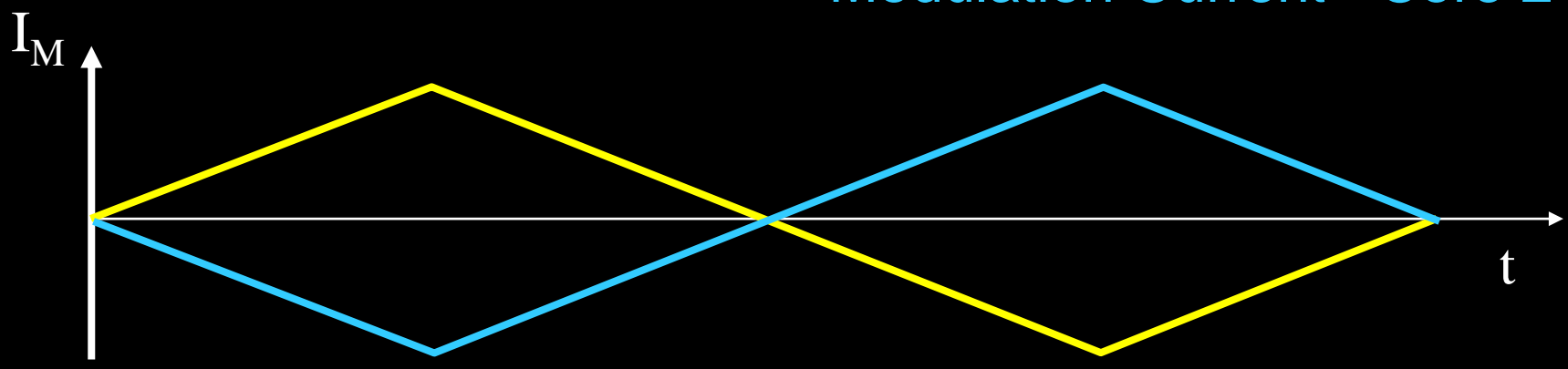


DCCT Principle – Case 1: no beam

Hysteresis loop of modulator cores

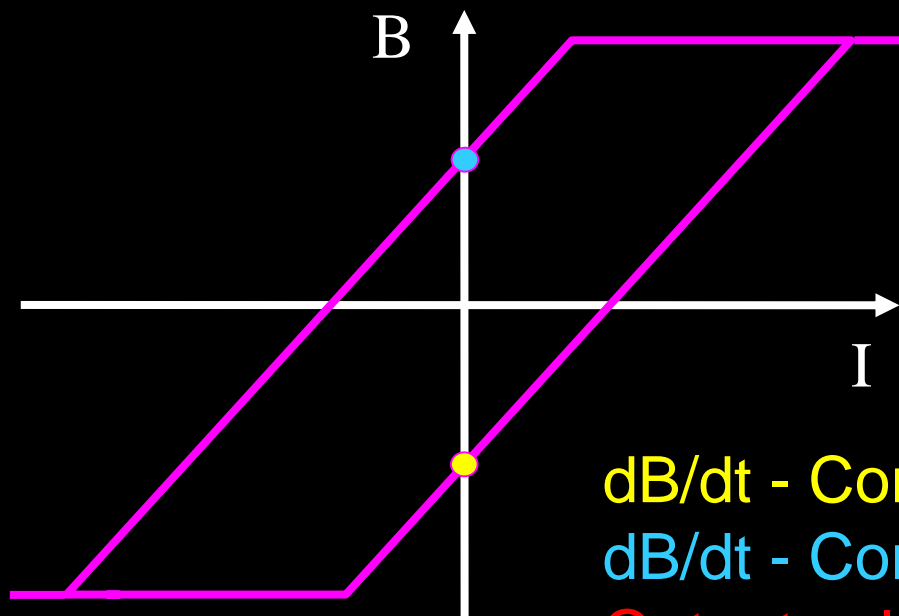


Modulation Current - Core 1
Modulation Current - Core 2



DCCT Principle – Case 1: no beam

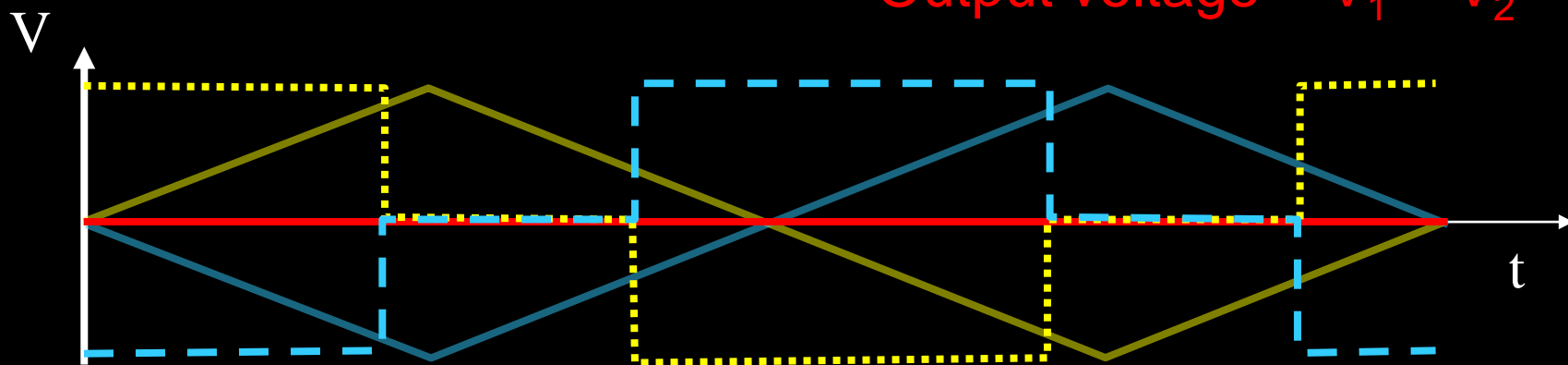
$$V \propto \frac{dB}{dt}$$



dB/dt - Core 1 (V_1)

dB/dt - Core 2 (V_2)

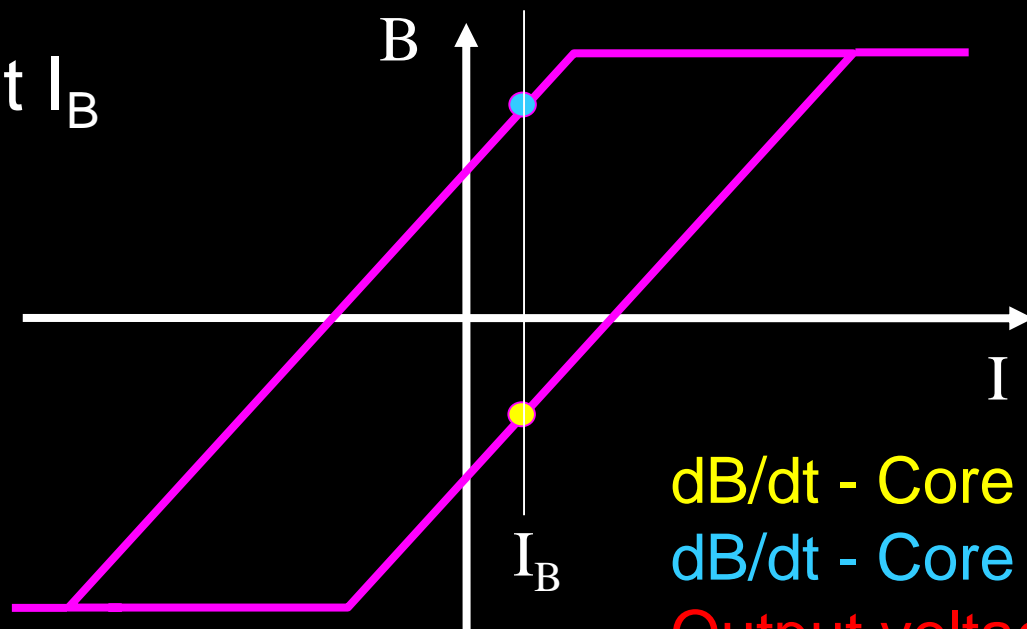
Output voltage = $V_1 - V_2$



DCCT Principle – Case 2: with beam

Beam Current I_B

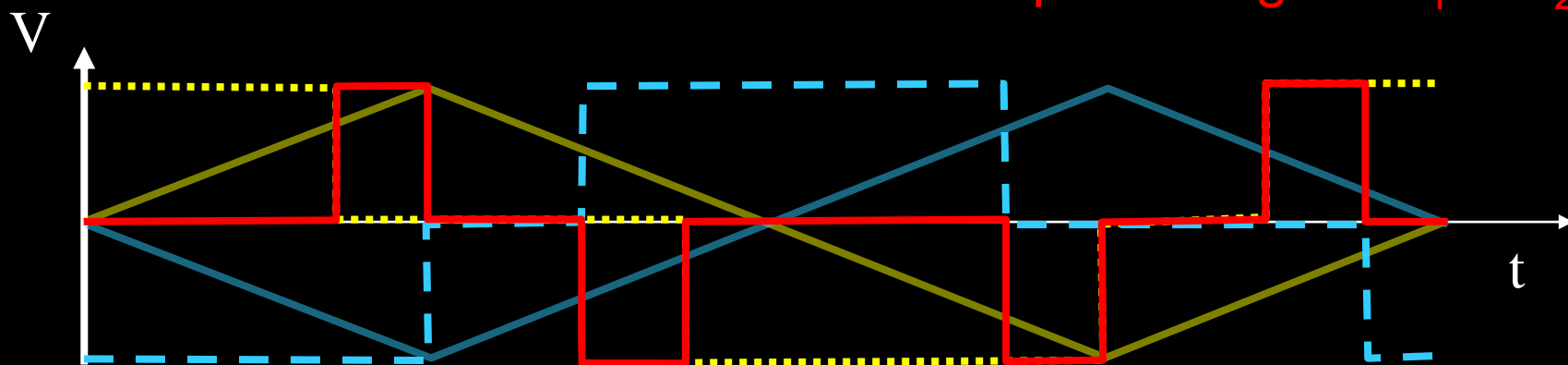
Output signal is at
TWICE
the modulation
frequency



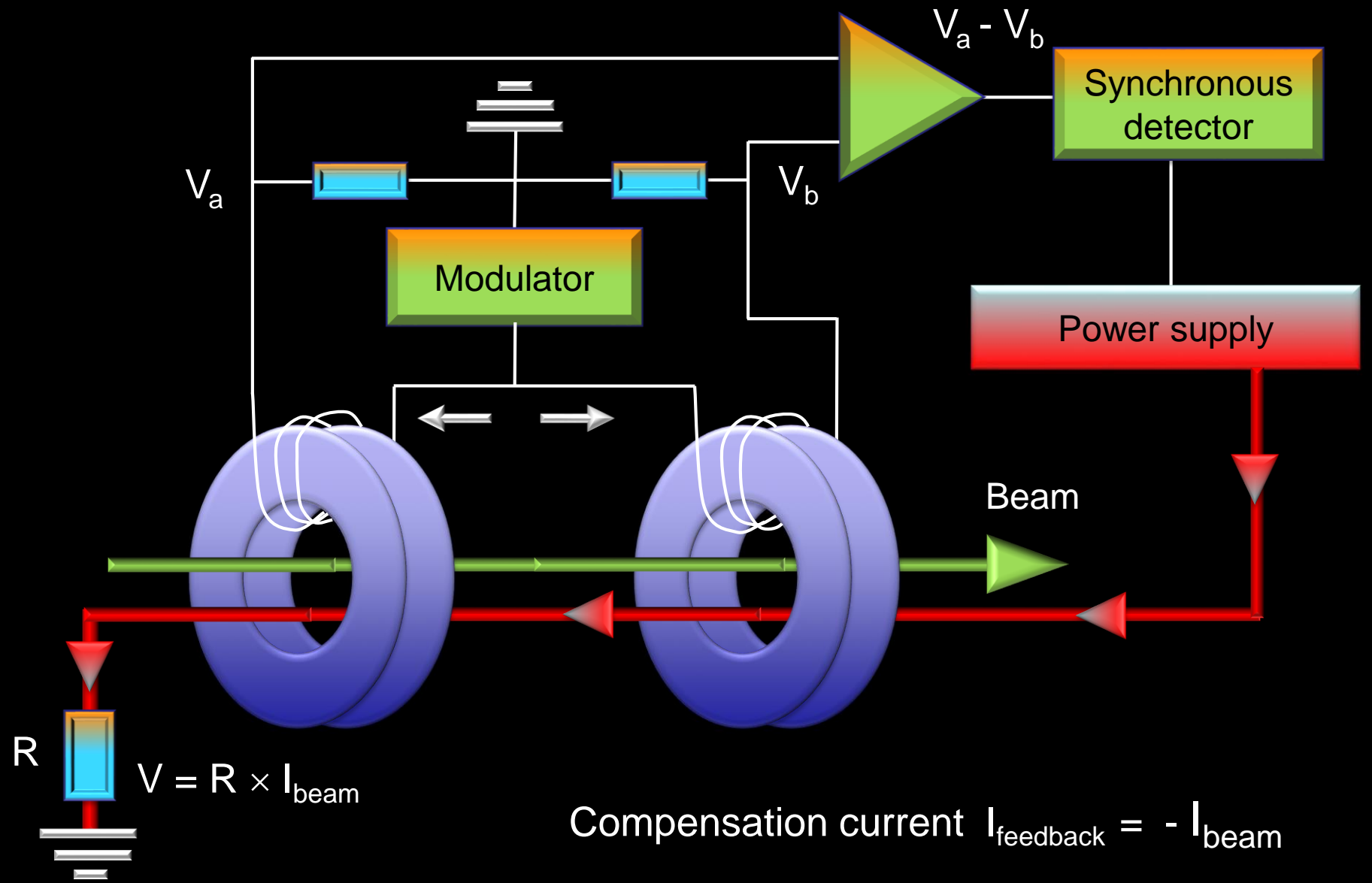
$\frac{dB}{dt}$ - Core 1 (V_1)

$\frac{dB}{dt}$ - Core 2 (V_2)

Output voltage = $V_1 - V_2$



Zero Flux DCCT Schematic





BCTs in Operation

- Provide the general visual diagnostics for most accelerators
- LHC Operation Pages
 - Total intensity measurement
 - Lifetime calculation





The Typical Instruments

- **Beam Position**
 - electrostatic or electromagnetic pick-ups and related electronics
- **Beam Intensity**
 - beam current transformers
- **Beam Profile**
 - secondary emission grids and screens
 - wire scanners
 - synchrotron light monitors
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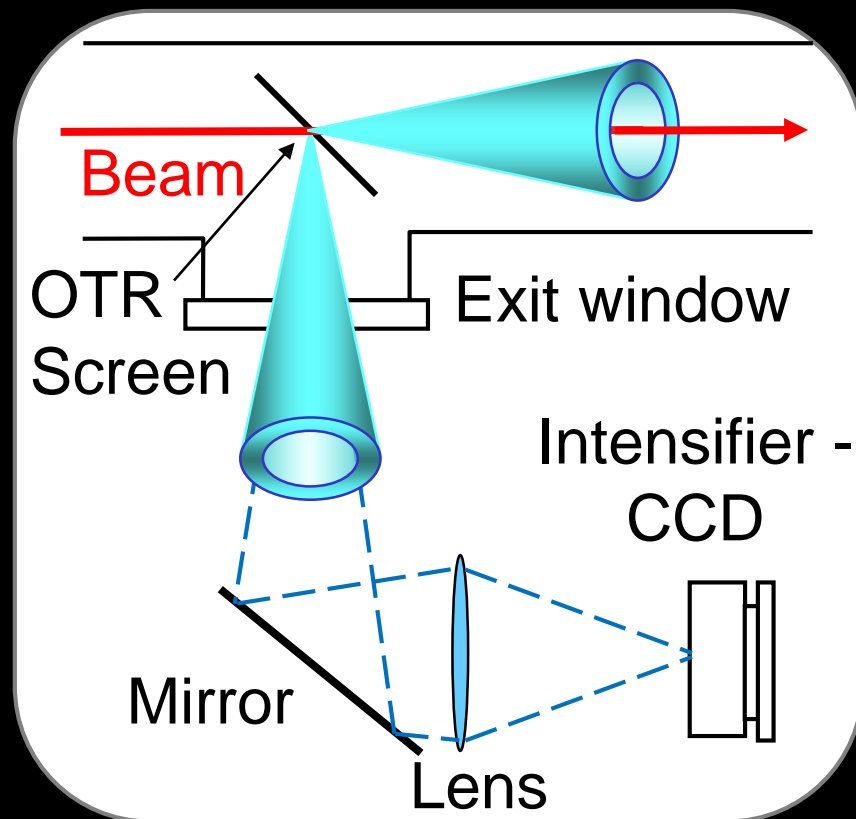
Beam Profile Monitoring using Screens

• Screen Types

- Luminescence / Scintillating Screens
 - Destructive (thick) but work with low intensities
- Optical Transition Radiation (OTR) screens
 - Much less destructive (thin) but require higher energy / intensity beam

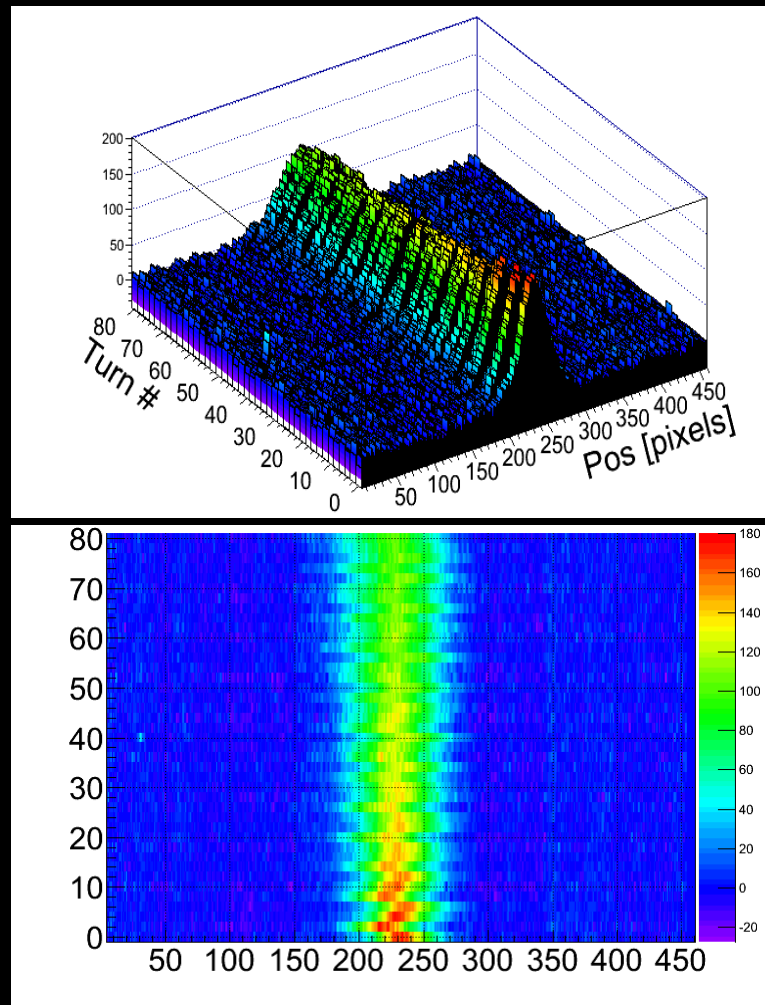
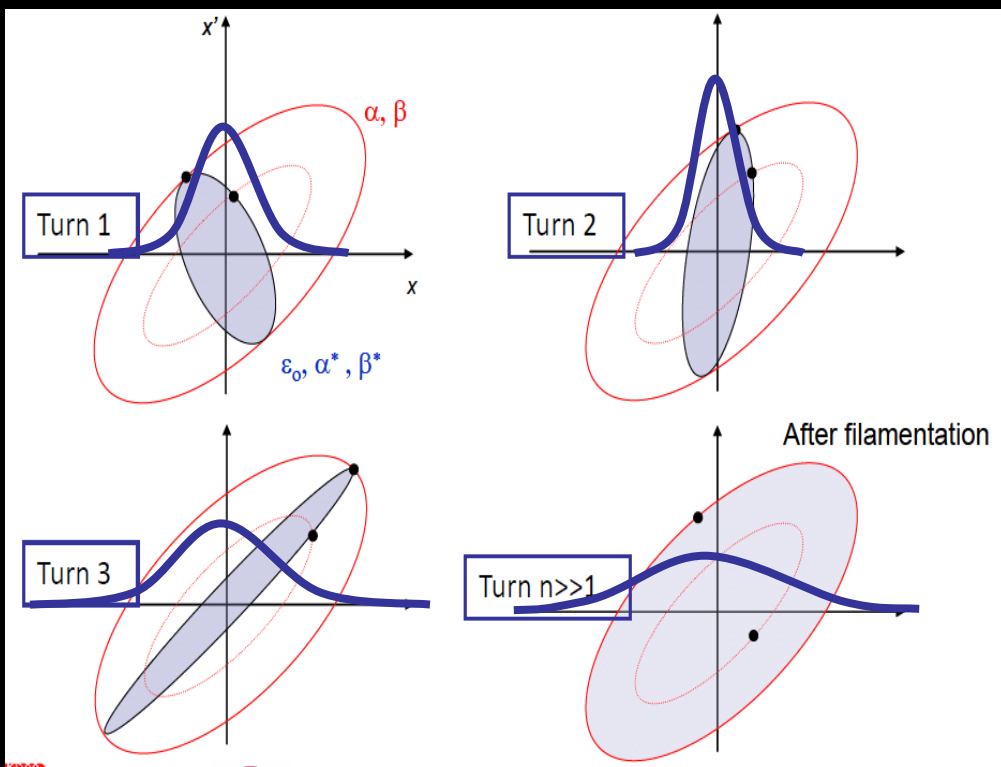
• OTR

- Radiation emitted when a charged particle goes through an interface with different dielectric constants
- Surface phenomenon allows use of very thin screens ($\sim 10\mu\text{m}$)
 - Can use multiple screens with single pass in transfer lines
 - Can leave it in for hundreds of turns e.g. for injection matching



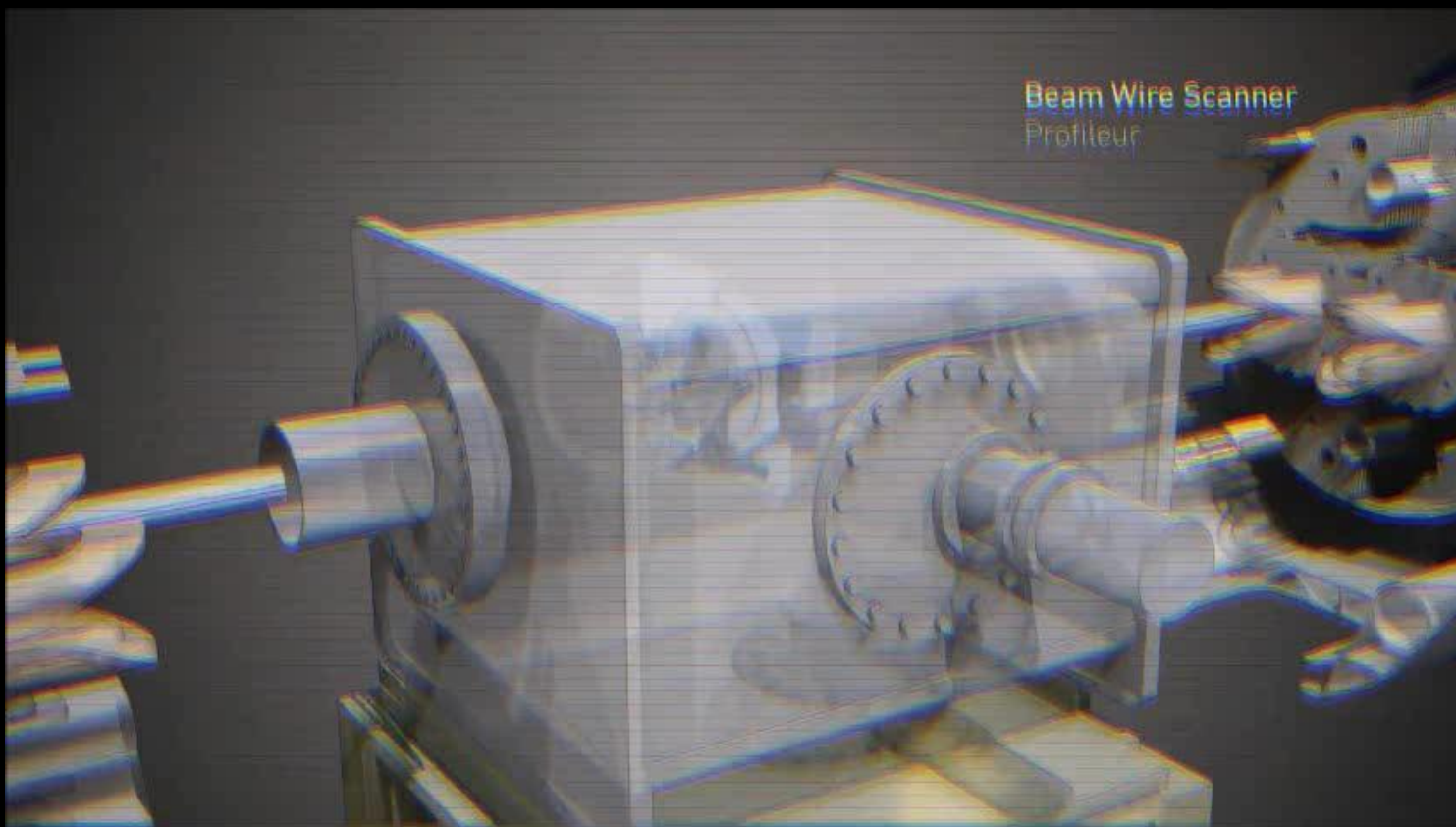
Measurements with Screens

- Injection matching measurements with OTR
 - Filamentation
 - Machine Settings Mismatch

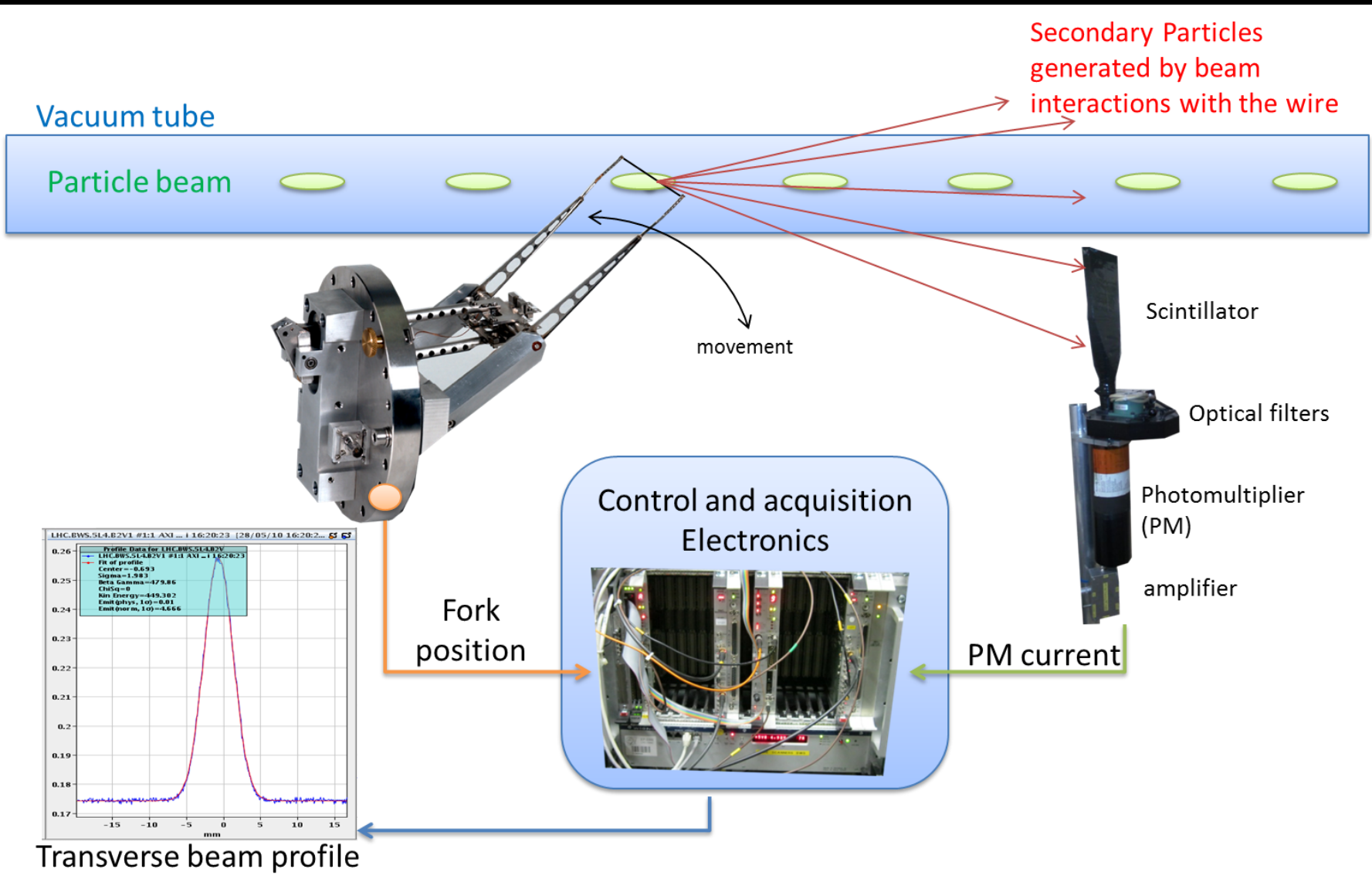


Beam Profile Monitoring using Wire-Scanners

- A thin wire is moved across the beam
 - Has to move fast to avoid excessive heating of the wire
- Detection
 - Secondary particle shower detected outside vacuum chamber using scintillator/photo-multiplier
- Correlating wire position with detected signal gives the beam profile

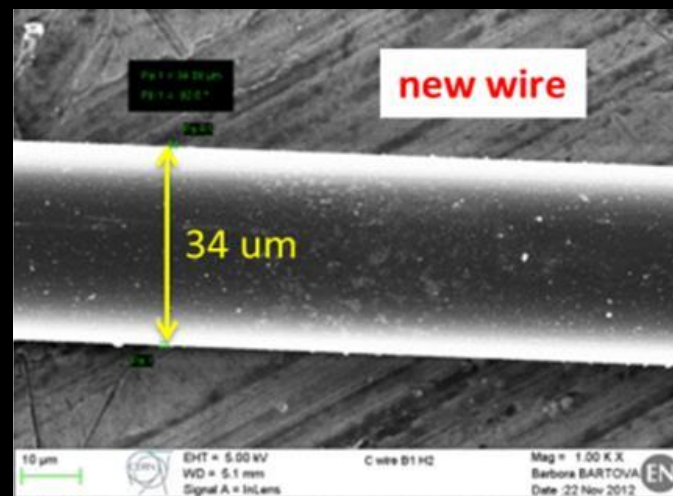
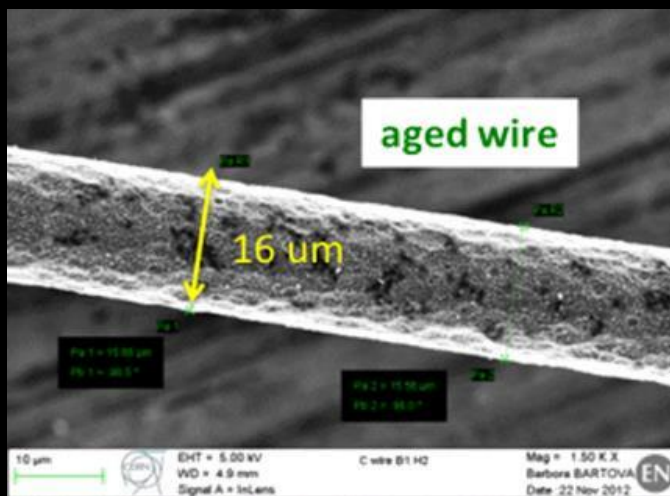


Beam Profile Monitoring using Wire-Scanners

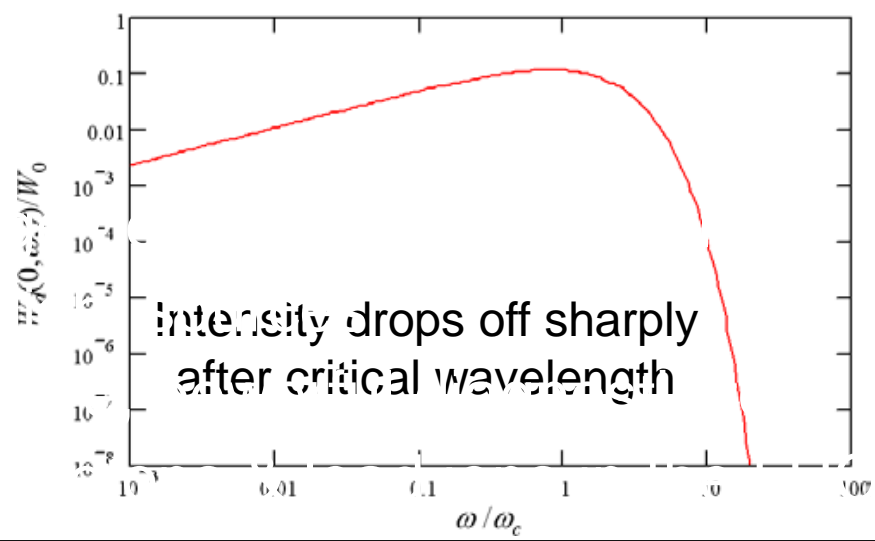
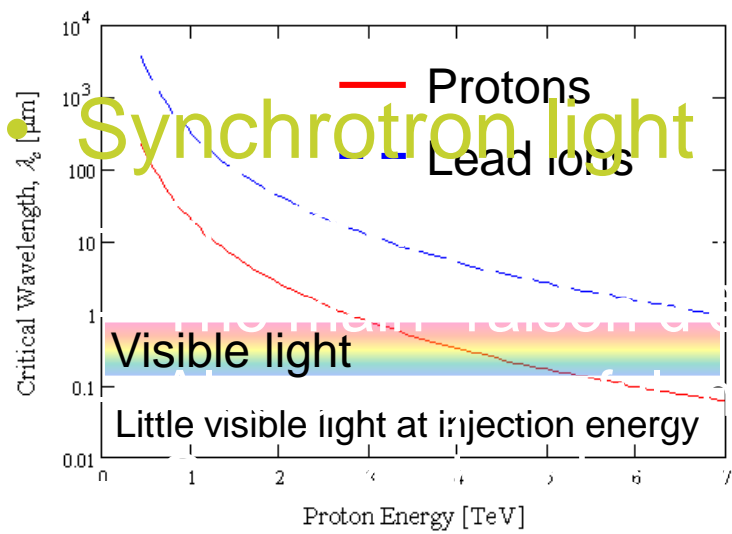
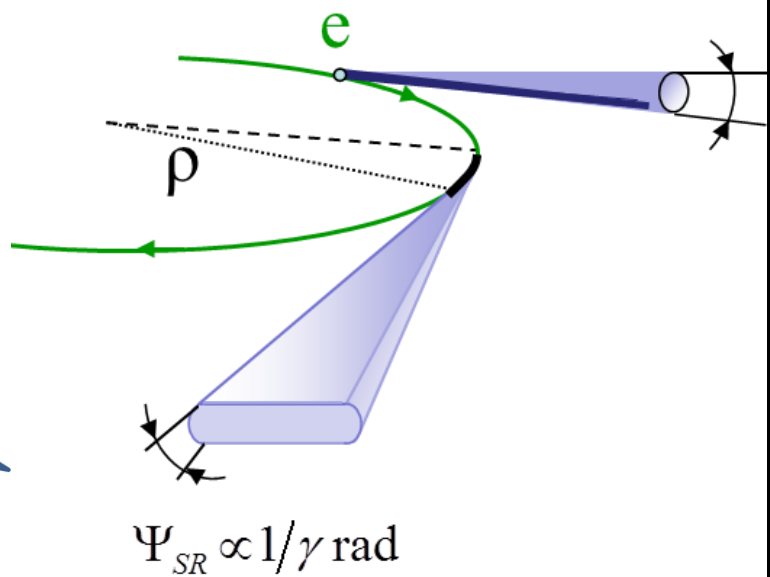
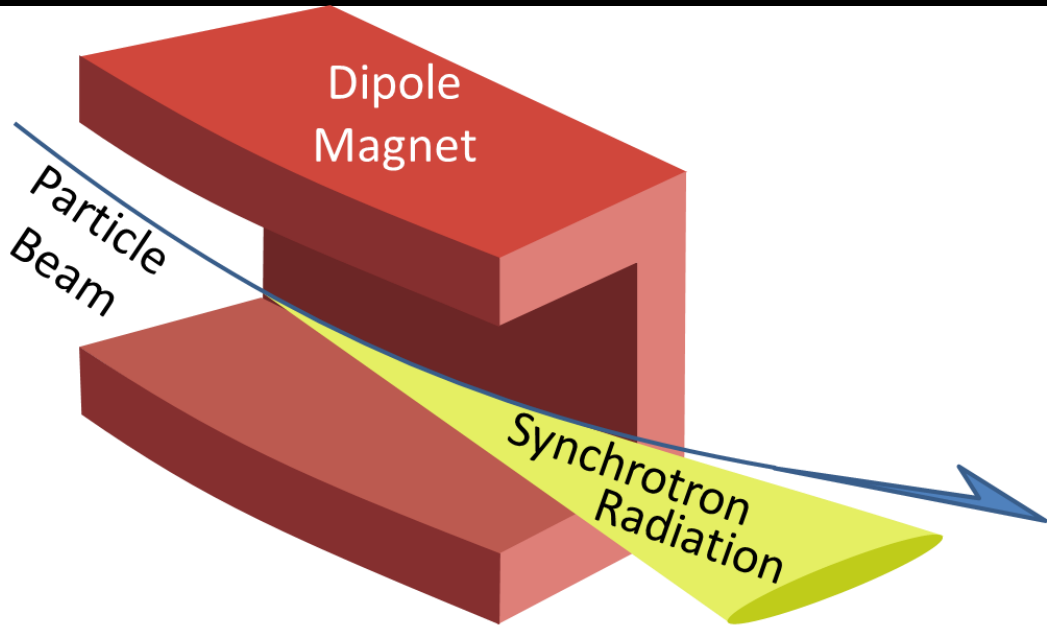


Limitation of WireScanners

- **Wire Breakage – why?**
 - Brittle or Plastic failure (error in motor control)
 - Melting/Sublimation (main intensity limit)
 - Due to energy deposition in wire by proton beam
- **Temperature evolution depends on**
 - Heat capacity, which increases with temperature!
 - Cooling (radiative, conductive, thermionic, sublimation)
 - Negligible during measurements (Typical scan 1 ms & cooling time constant ~10-15 ms)
- **Wire Choice**
 - Good mechanical properties, high heat capacity, high melting/sublimation point
 - E.g. Carbon which sublimates at 3915K



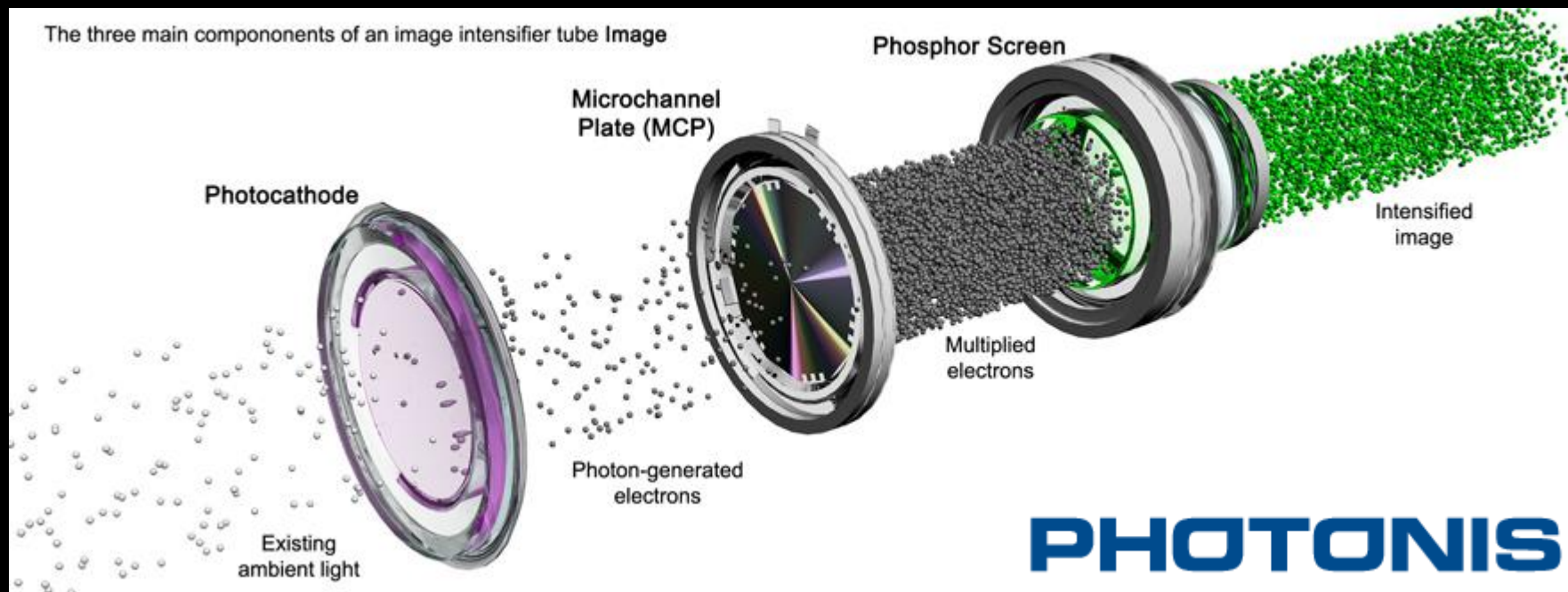
Synchrotron Light Monitors



Synchrotron Light Image Acquisition

- **Using various cameras**

- Standard CCD cameras for average beam size measurements
- Gated intensified camera
 - For bunch by bunch diagnostics
- Streak cameras
 - For short bunch diagnostics



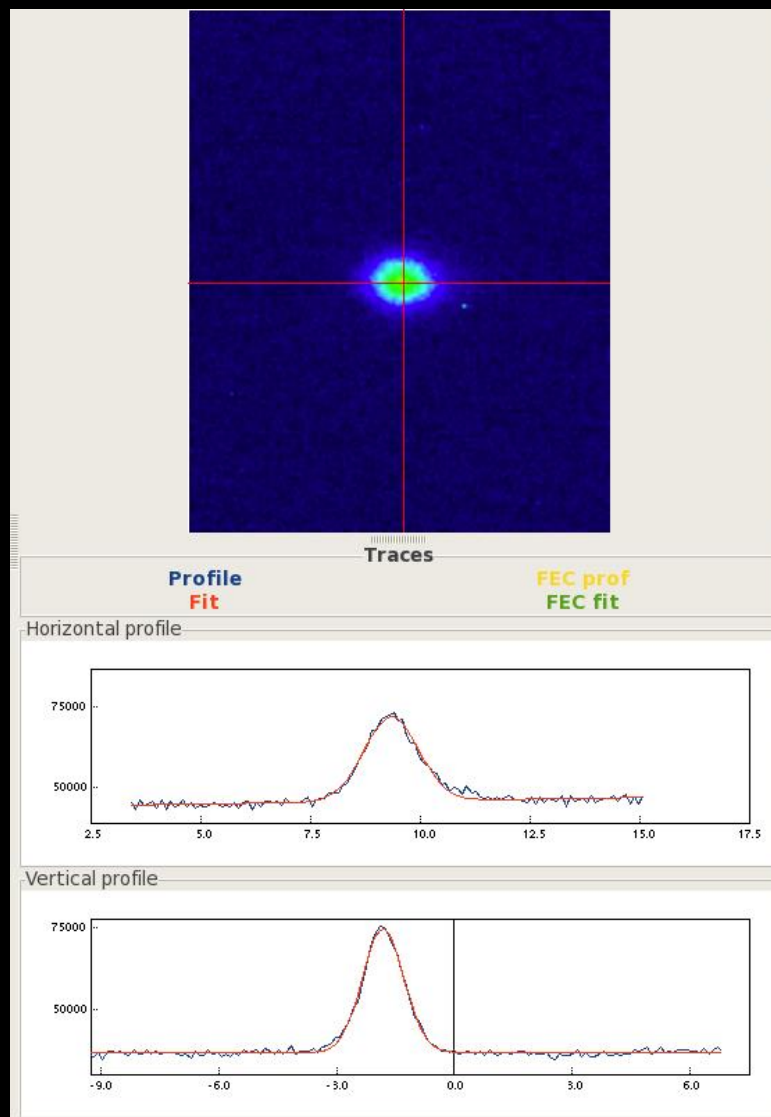
Synchrotron Light Imaging

- **Proton Beam Example**

- LHC single bunch
~1.1e11p @ 3.5 TeV
- Acquisition accumulated
over 4 turns at 200Hz

- **Limitations**

- Aberrations
 - Mitigated by careful design
- Diffraction
 - Need to go to lower wavelengths as the beam size becomes smaller

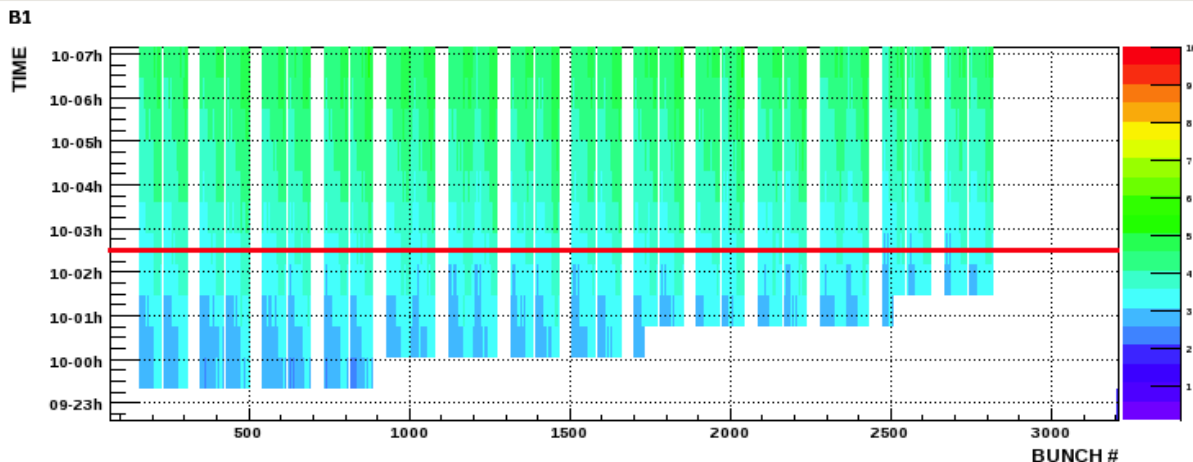


Bunch by Bunch Profile Measurement

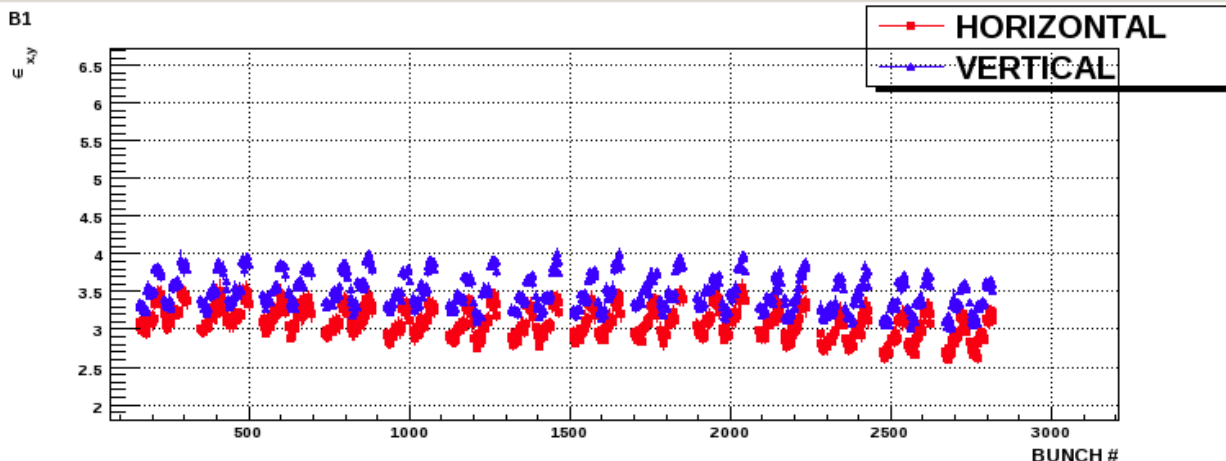
Diagnostics

- Allows diagnosis of systematic emittance patterns from the LHC injectors
 - In this case variations in the emittance from the 4 different PS Booster rings

V Bunch per Bunch Evolution



Bunch per Bunch Slice @ T=RED LINE ABOVE



Measuring Ultra Short Bunches

- **Next Generation FELs & Linear Colliders**

- Use ultra short bunches to increase brightness or improve luminosity

- **How do we measure such short bunches?**

- Direct Observation

- Produce light & observe with dedicated instruments
- Use of RF techniques
- Use laser pulses and sampling techniques

- Indirect Calculation

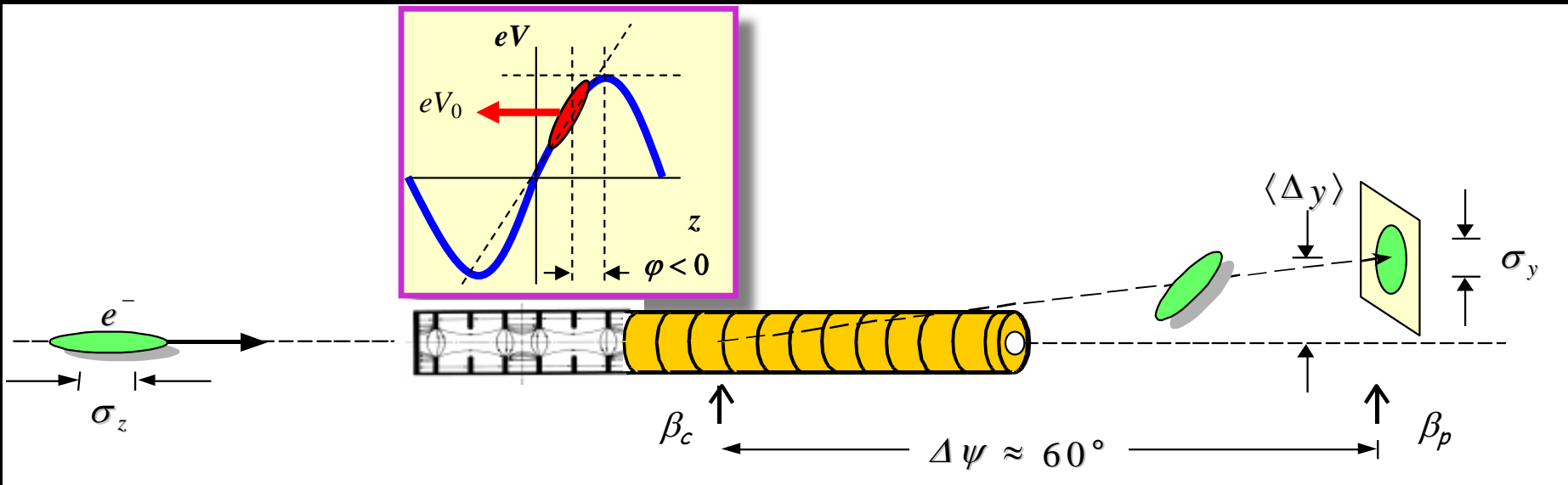
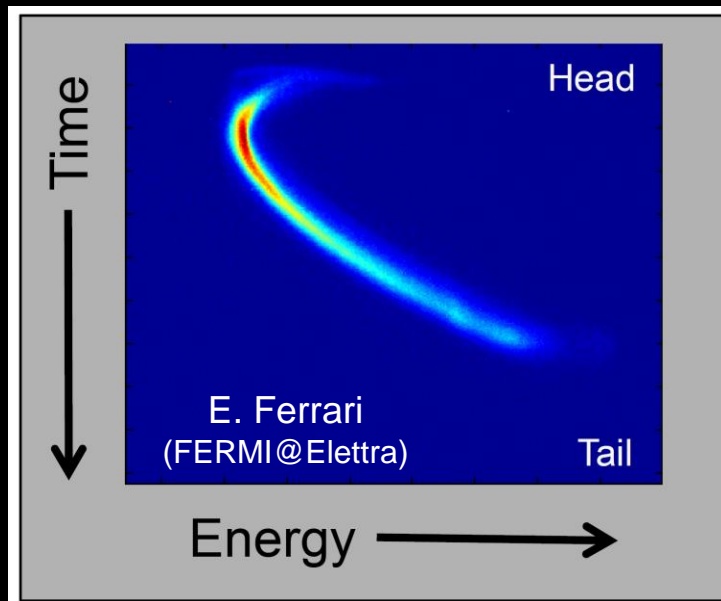
- Reconstruct bunch length from frequency spectrum
 - Either directly from the bunch or through its radiation spectrum

p ⁺ @ LHC	250ps
H ⁻ @ SNS	100ps
e ⁻ @ ILC	500fs
e ⁻ @ CLIC	130fs
e ⁻ @ XFEL	80fs
e ⁻ @ LCLS	<75fs

Measuring Ultra Short Bunches

• RF Deflection

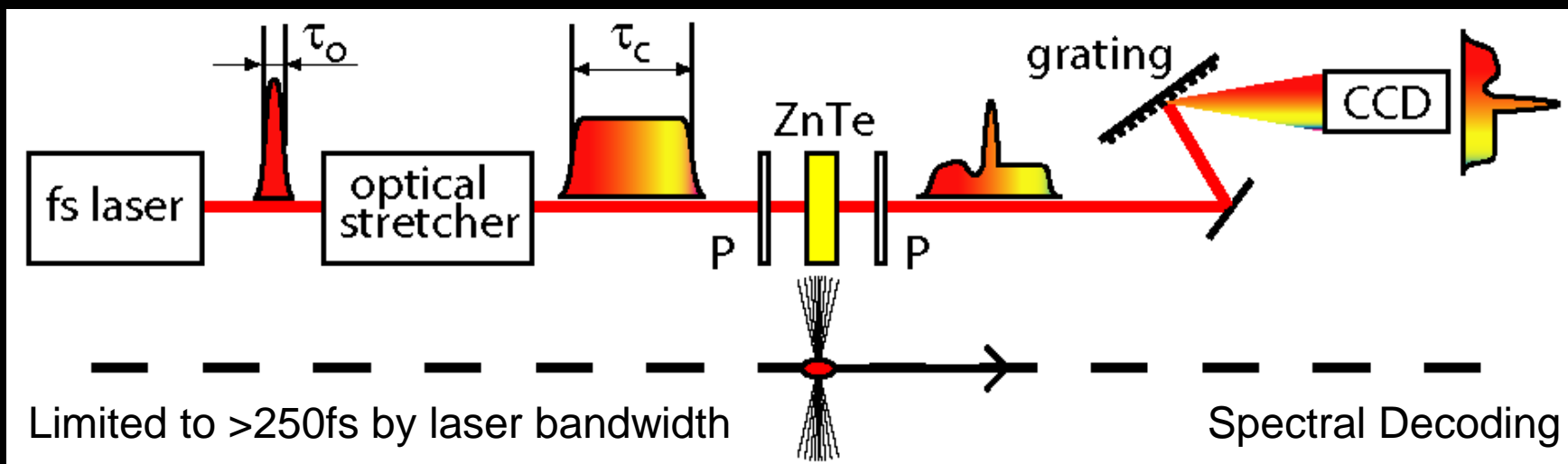
- Converts time information to spatial information
- Coupled to spectrometer also provides energy information
- Destructive technique
- Resolution down to 1.3 fs
 - X-band RF cavity
 - Linac Coherent Light Source (SLAC)



Measuring Ultra Short Bunches

- **Electro-Optic Sampling**

- Use a birefringent crystal to map the electric field of the bunch onto a chirped (time varying wavelength) laser pulse
 - Electric field modified the polarisation of the light in the crystal
- Sample this light pulse to obtain the longitudinal bunch distribution
 - Can be done in a variety of ways
- Non destructive technique
- Resolution down to 30 fs possible





The Typical Instruments

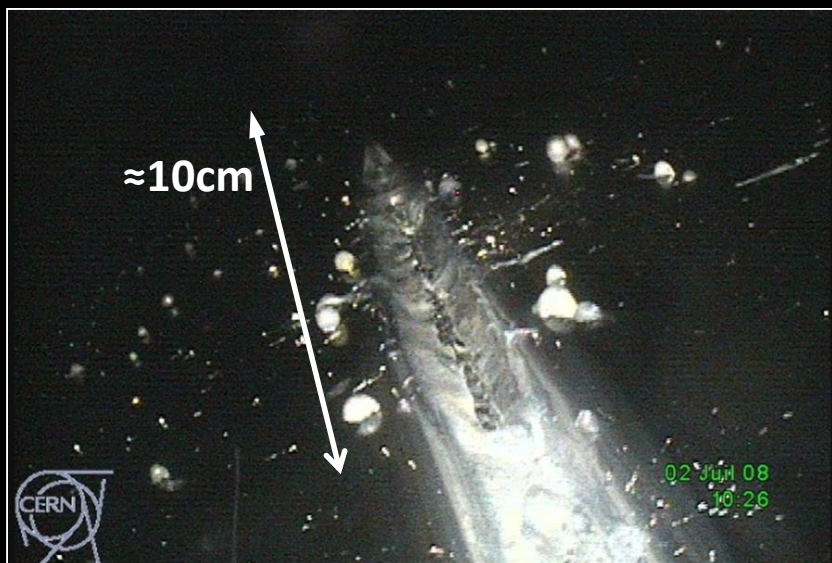
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Beam Loss Detectors

- **Role of a BLM system:**
 - Protect the machine from damage
 - Dump the beam to avoid magnet quenches (for SC magnets)
 - Diagnostic tool to improve the performance of the accelerator
- **E.g. LHC**

Stored Energy	
Beam 7 TeV	2 x 362 MJ
2011 Beam 3.5 TeV	above 2 x 100 MJ

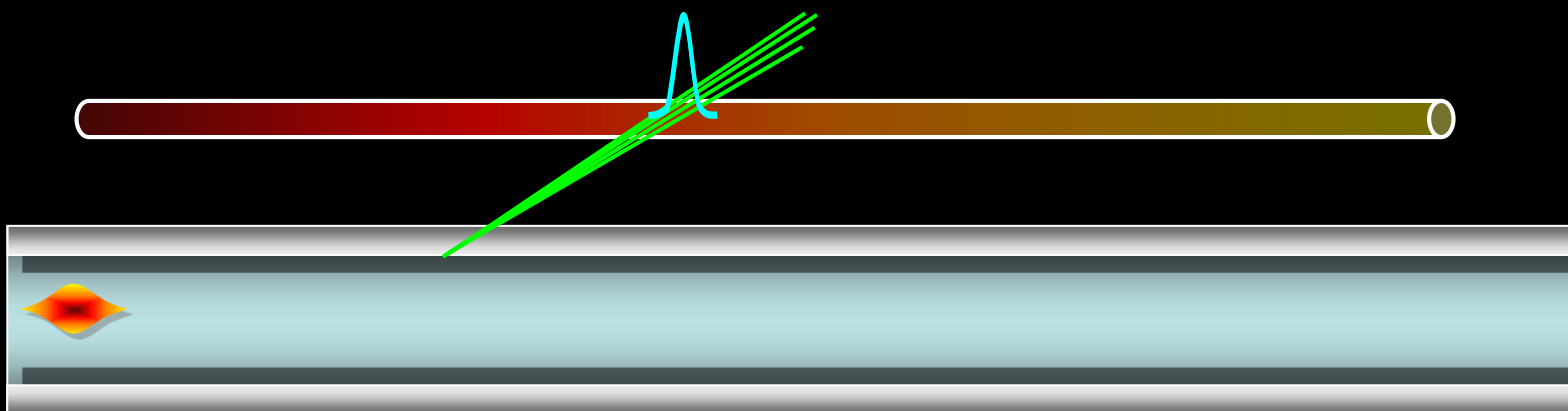
Quench and Damage at 7 TeV	
Quench level	$\approx 1 \text{ mJ/cm}^3$
Damage level	$\approx 1 \text{ J/cm}^3$



- **SPS incident**
 - June 2008
 - 2 MJ beam lost at 400 GeV

Beam Loss Detectors

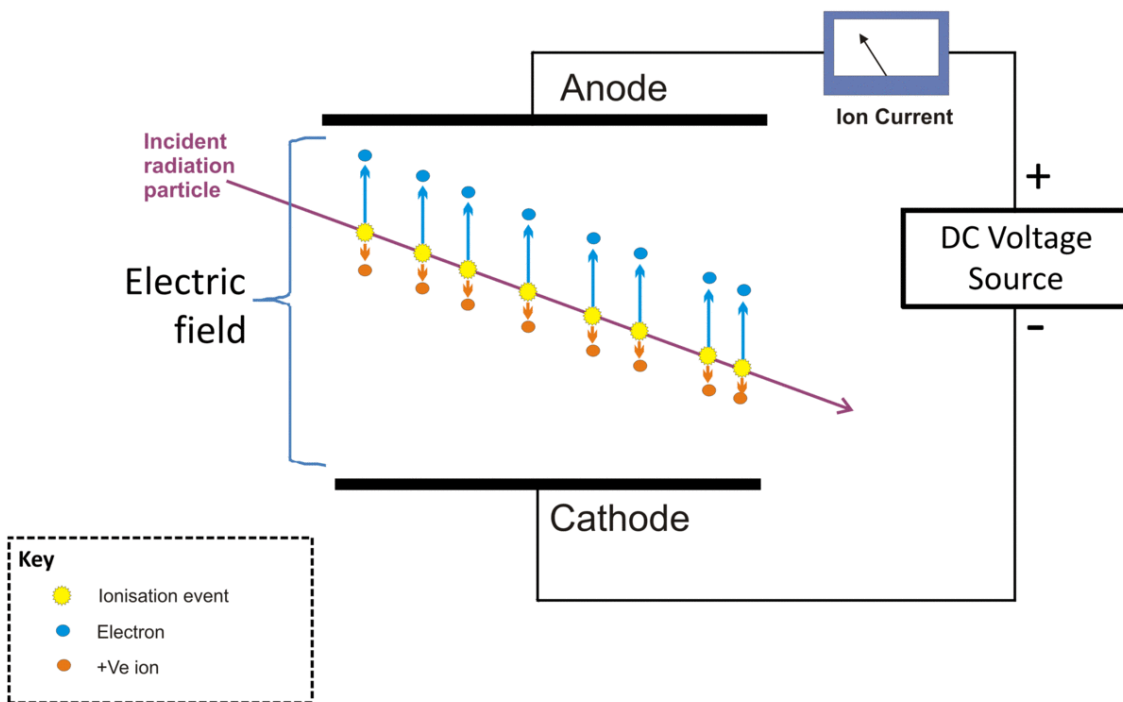
- Common types of monitor
 - Long ionisation chamber (charge detection)
 - Up to several km of gas filled hollow coaxial cables
 - Position sensitivity achieved by comparing direct & reflected pulse
 - e.g. SLAC – 8m position resolution (30ns) over 3.5km cable length
 - Dynamic range of up to 10^4
 - Fibre optic monitors
 - Electrical signals replaced by light produced through Cerenkov effect



Beam Loss Detectors

- Common types of monitor
 - Ionisation chambers
 - Dynamic range of $< 10^8$
 - Slow response (μs) due to ion drift time

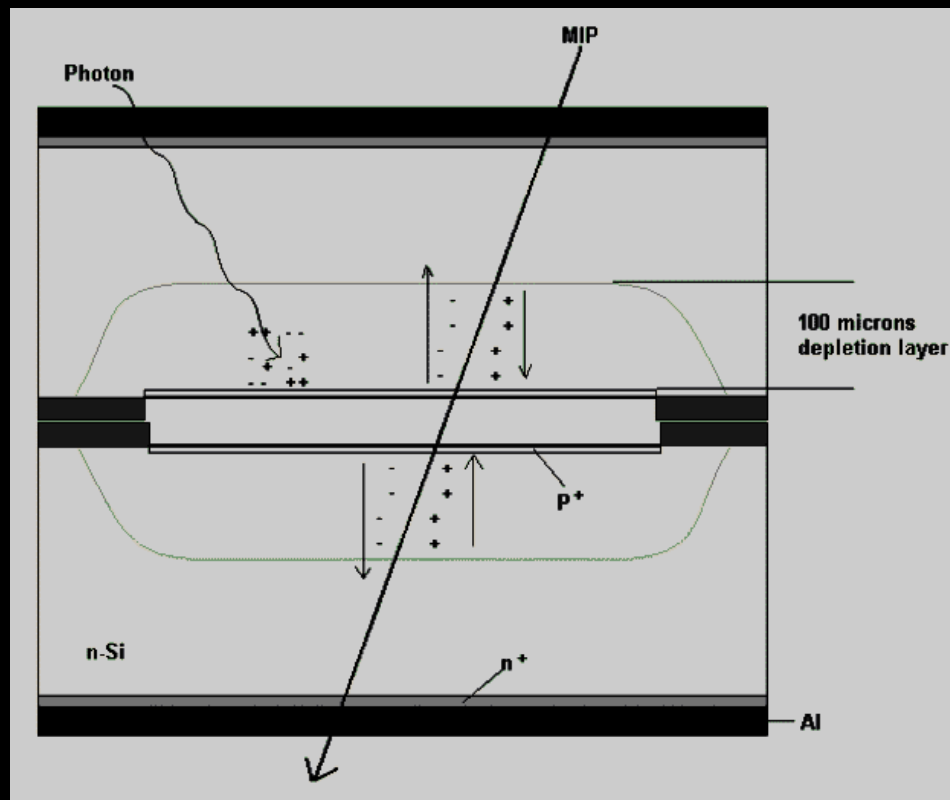
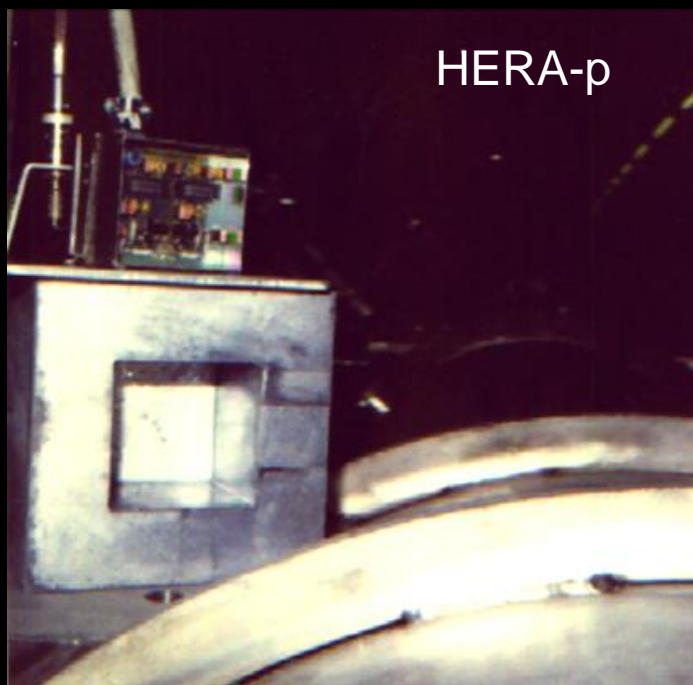
Visualisation of ion chamber operation



Beam Loss Detectors

- Common types of monitor

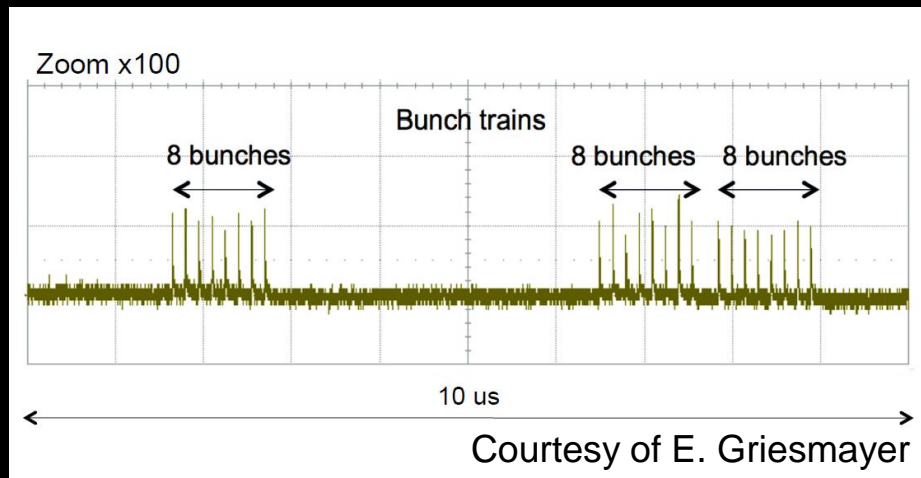
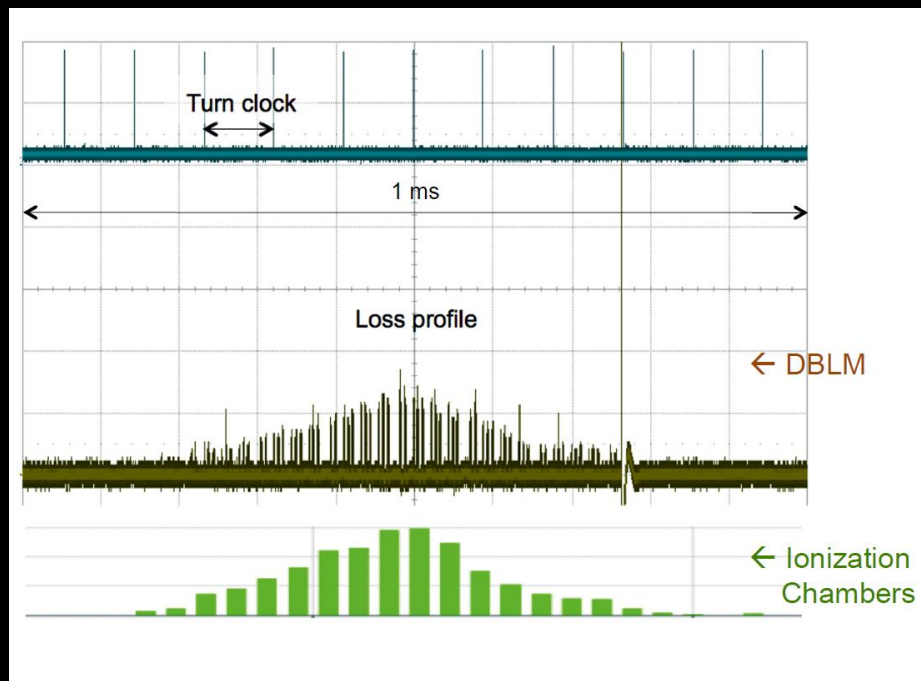
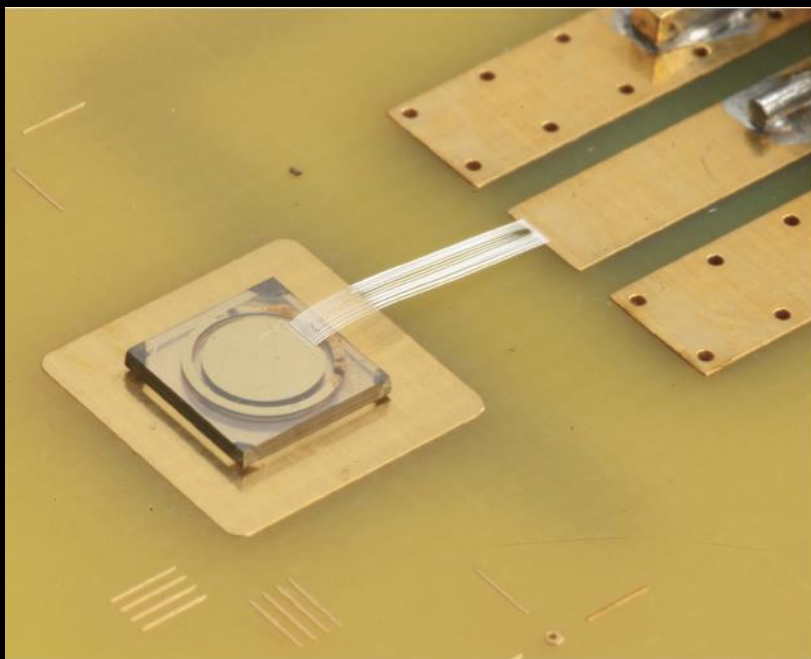
- PIN photodiode (solid state ionisation chamber)
 - Detect coincidence of ionising particle crossing photodiodes
 - Count rate proportional to beam loss with speed limited by integration time
 - Can distinguish between X-rays & ionising particles
 - Dynamic range of up to 10^9



Beam Loss Detectors – New Materials

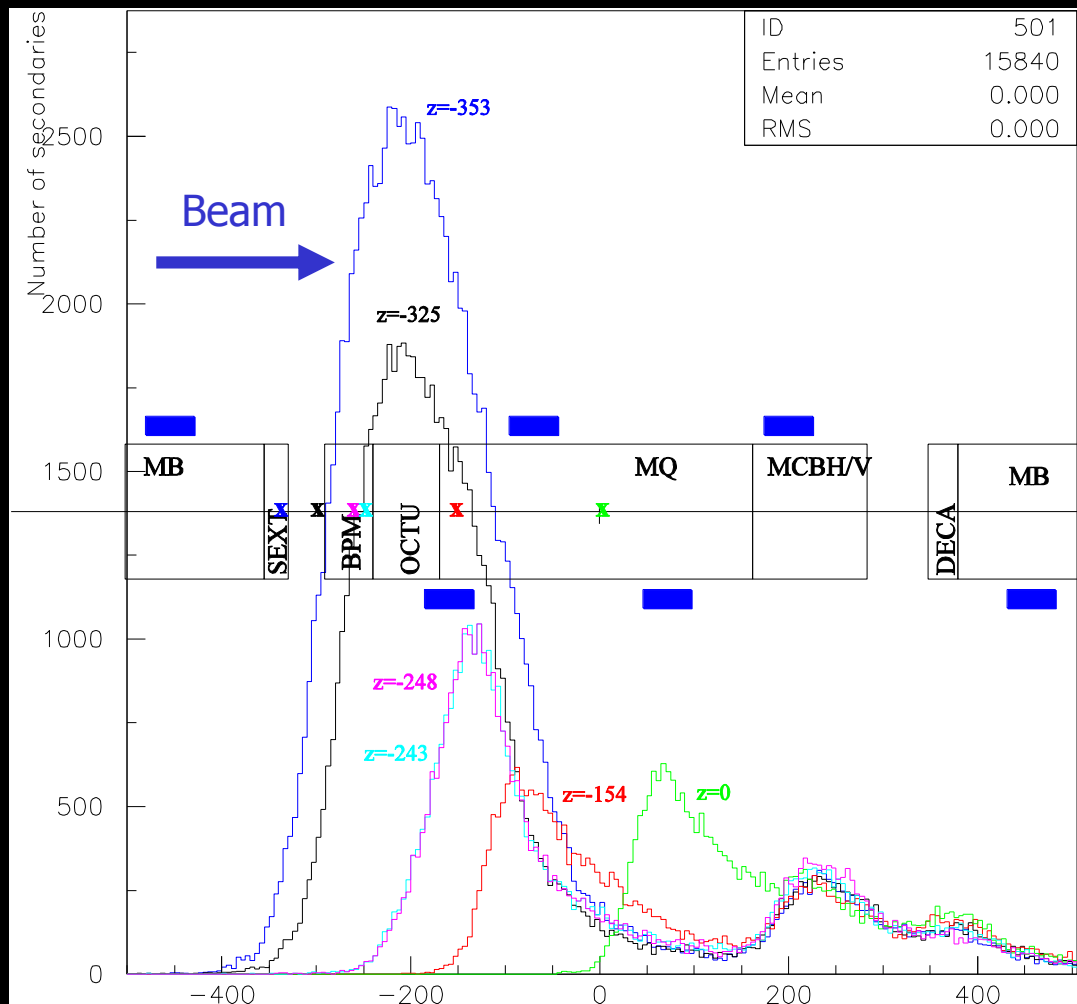
- **Diamond Detectors**

- Fast & sensitive
- Used in LHC to distinguish bunch by bunch losses
- Investigations now ongoing to see if they can work in cryogenic conditions



Where should we place our BLMs?

- **Secondary shower simulation**
 - to determine what energy is deposited where
- **Impact position varied along quadrupole**
- **Position of detectors optimized**
 - to catch losses & minimize uncertainty of ratio of energy deposition in coil and detector
 - To discriminate between Beams
 - To have good probability that losses are seen by two BLM detectors





Summary

- This was an overview of the common types of instruments that can be found in most accelerators
 - Only small subset of those currently in use or being developed
 - Many exotic instruments are tailored for specific accelerator needs
- Tomorrow you will see how to use these instruments to run and optimise accelerators
 - Introduction to Accelerator Beam Diagnostics (H. Schmickler)

Want to know more? Then Join the afternoon course:

- Beam Instrumentation & Diagnostics
 - For an in-depth analysis of these instruments & their applications
 - 3 Sessions : BPM design & Tune Measurement
 - Using specially developed software & laboratory measurements
 - 2 Sessions : Emittance measurements & ultra-fast diagnostics
 - 1 Session : Design your own beam instrumentation suite
 - Present your Group's ideas on how to equip an accelerator